











SNAS740B -OCTOBER 2017-REVISED JANUARY 2019

LMX2572

# LMX2572 6.4-GHz Low power wideband RF synthesizer with phase synchronization and JESD204B support

## 1 Features

- Output frequency: 12.5 MHz to 6.4 GHz
- Low power consumption: 75 mA at 3.3-V supply
- -106-dBc/Hz Phase noise at 100-kHz offset with 6.4-GHz carrier
- PLL figure of merit: -232 dBc/Hz
- PLL normalized 1/f noise: -123.5 dBc/Hz
- · 32-Bit Fractional-N divider
- Remove integer boundary spurs with programmable input multiplier
- Synchronization of output phase across multiple devices
- Support for JESD204B SYSREF with programmable delay
- Support for ramp and chirp functions
- Support for FSK direct digital modulation
- Two programmable output power level differential outputs
- Fast VCO calibration speed: < 20 μs</li>
- Single 3-V to 3.5-V power supply

# 2 Applications

- Test and measurement equipment
- Digital 2-way radios
- Low power radio communication systems
- Satellite communication
- · Wireless microphones
- · Propriety wireless connectivity
- MIMO
- RADAR
- High-speed data converter clocking

# 3 Description

The LMX2572 is a low-power, high-performance wideband synthesizer that can generate any frequency from 12.5 MHz to 6.4 GHz without using an internal doubler. The PLL delivers excellent performance while consuming just 75 mA from a single 3.3-V supply.

For applications like digital mobile radio (DMR) and wireless microphones, the LMX2572 supports FSK modulation. Discrete level FSK and pulse-shaping FSK are supported. Direct digital FSK modulation is achievable through programming or pins.

The LMX2572 allows users to synchronize the output of multiple devices and also enables applications that need deterministic delay between input and output. The LMX2572 provides an option to adjust the phase with fine granularity to account for delay mismatch on the board or within devices. A frequency ramp generator can synthesize up to two segments of ramp in an automatic ramp generation option or a manual option for maximum flexibility. The fast calibration algorithm allows the user to change frequencies faster than 20 µs. The LMX2572 also supports generating or repeating SYSREF (compliant to JESD204B standard) making it an ideal low-power, low-noise clock source for clocking high-speed data converters. Fine delay adjustment is provided in this configuration to account for delay differences of board

The LMX2572 integrates LDOs from a single 3.3-V supply, thus eliminating the need for onboard lownoise LDOs.

# Device Information<sup>(1)</sup>

PART NUMBER	PACKAGE	BODY SIZE (NOM)		
LMX2572	VQFN (40)	6.00 mm × 6.00 mm		

(1) For all available packages, see the orderable addendum at the end of the data sheet.

#### **Functional Block Diagram** CPout Vtune OSCinP Charge Θ ▶ RFoutAP OSCinM Divider 4MULT HO Divider Pump x2 ▶ RFoutAM CSB N-Divider -2/4/8 /256 LDOs Serial Interface SCK ▶ RFoutBP ▶ RFoutBM Lock Detect or Phase Ramp Generator ΣΔ MUXout ◀ Enable SYSREF Register Readback Sync **FSK Generator** Modulato SYNC ĊE RampClk RampDir SysRefReq



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# 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

CI	nanges from Revision A (October 2017) to Revision B	Page
•	Changed RampDir pin description from:ramp size selection to:ramp segment selection	4
•	Changed RFoutAM pin description from: High impedance to: Low impedance	4
•	Changed RFoutAP pin description from: High impedance to: Low impedance	4
•	Changed RFoutBM pin description from: High impedance to: Low impedance	4
•	Changed RFoutBP pin description from: High impedance to: Low impedance	4
•	Changed VbiasVCO pin decoupling capacitor requirement	5
•	Changed VbiasVCO2 pin decoupling capacitor requirement	5
•	Changed VccMASH pin decoupling capacitor requirement	5
•	Changed VccVCO pin decoupling capacitor requirement	5
•	Changed VccVCO2 pin decoupling capacitor requirement	5
•	Changed VregVCO pin decoupling capacitor requirement	5
•	Added Vtune pin shunt capacitor requirement	5
•	Changed V <sub>OH</sub> and V <sub>OL</sub> data in Electrical Characteristics	8
•	Changed SCK to CSB low time symbol	8
•	Changed Figure 28	13
•	Added charge pump gain table	16
•	Deleted sentence 'When the device comes out of the powered down state, either by resuming the POWERDOWN bit to zero or by pulling back CE pin HIGH (if it was powered down by CE pin), it is required that register R0 with FCAL_EN = 1 be programmed again to re-calibrate the device.' from the <i>Powerdown</i> section	18
•	Added sentence 'The wake-up time for the device to come out of the powered state is adjustable.' to the  Powerdown section	
•	Changed Programming Sequence step from: Wait 100 µs to: Wait 500 µs	21
•	Changed R6 initial programming from: No to: Depends	21
•	Changed R52 initial programming from: No to: Yes	22

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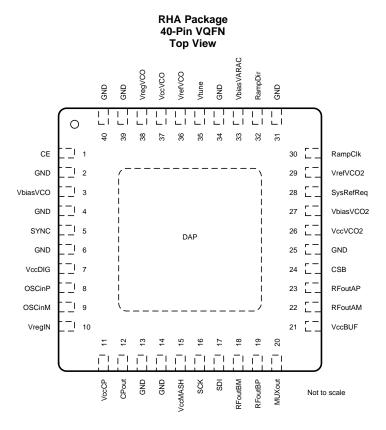
# **Revision History (continued)**

•	Changed Advance Information to Production Data Release	1
Cł	nanges from Original (August 2017) to Revision A	Page
<u>•</u>	Added an application section for powerup wake up time	75
•	Added an application section for external loop filter	
•	Changed ADR_HOLD = 1 to ADD_HOLD = 1	
•	Deleted paragraph 'For ramping that are not calibration free, the ramp waveform is more like a staircase ramp. For all automatic ramping waveforms, be aware that there is a very small phase disturbance as the VCO crosses over the integer boundary, so one might consider using the input Multiplier to avoid these or timing the VCO calibration at integer boundaries.' from the <i>Automatic Ramping Mode</i> section	
•	Changed RAMP_THRESH value suggestion	69
•	Changed RAMP_MODE = 1 to RAMP_MANUAL = 1 in the Manual Ramping Mode section	
•	Changed setup procedure step from:divide N to:set N = N' / 2	68
•	Changed Figure 165 and Figure 166	65
•	Changed register R114, FSK_MODE_SEL value definition	61
•	Changed VCO_CAPCTRL_STRT reset value	51
•	Changed from: MASH reset count to: This register	
•	Changed register R58, INPIN_LVL value definition	
•	Changed register R52 programming value	
•	Changed register R46, OUTB_MUX value definition	
•	Deleted VCO_SEL_STRT_EN = 1 in Register 20 Field Descriptions	
•	Changed register R20 default value	
•	Changed R15[0] from: 1 to: 0	
•	Changed register R14 default value	
•	Changed MULT bit description from:30 MHz to:40 MHz	
•	Added LDO_DLY in register R6	
•	Changed register R0, FCAL_HPFD_ADJ value definition	
•	Changed R52[0] from: 0 to: 1	
•	Changed R20[14] from: 0 to: 1	
•	Changed R15 POR value	
•	Changed R15[0] from: 1 to: 0	
•	Added LDO_DLY in register R6	

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# 5 Pin Configuration and Functions



# **Pin Functions**

	PIN			
NAME	NO.	I/O	DESCRIPTION	
CE	1	Input	Chip enable. High impedance CMOS input. 1.8-V to 3.3-V logic. Active HIGH powers on the device.	
CPout	12	Output	Charge pump output. Place C1 of loop filter close to this pin.	
CSB	24	Input	SPI latch. High impedance CMOS input. 1.8-V to 3.3-V logic.	
DAP	_	Ground	RF ground.	
	2, 4, 25, 31, 34, 39	Ground	VCO ground.	
GND	6, 14, 40	Ground	Digital ground.	
	13	Ground	Charge pump ground.	
MUXout	20	Output	Multiplexed output pin. Configurable between lock detect and register readback.	
OSCinM	9	Input	Reference input clock (–). High impedance self-biasing pin. Requires AC-coupling.	
OSCinP	8	Input	Reference input clock (+). High impedance self-biasing pin. Requires AC-coupling.	
RampClk	30	Input	Ramp trigger in automatic ramping mode or ramp clock in manual ramping mode. High impedance CMOS input. 1.8-V to 3.3-V logic.	
RampDir	32	Input	Ramp trigger in automatic ramping mode or ramp segment selection in manual ramping mode. High impedance CMOS input. 1.8-V to 3.3-V logic.	
RFoutAM	22	Output	Differential output A (–). Low impedance output. Requires AC-coupling.	
RFoutAP	23	Output	Differential output A (+). Low impedance output. Requires AC-coupling.	
RFoutBM	18	Output	Differential output B (–). Low impedance output. Requires AC-coupling. Configurable between RF output or SYSREF output.	
RFoutBP	19	Output	Differential output B (+). Low impedance output. Requires AC-coupling. Configurable between RF output or SYSREF output.	



#### Pin Functions (continued)

PIN I/O		1/0	DECORPORTION	
NAME	NO.	1/0	DESCRIPTION	
SCK	16	Input	SPI clock. High impedance CMOS input. 1.8-V to 3.3-V logic.	
SDI	17	Input	SPI data. High impedance CMOS input. 1.8-V to 3.3-V logic.	
SYNC	5	Input	Phase synchronization trigger. Configurable to accept CMOS input (1.8-V to 3.3-V logic) or differential input.	
SysRefReq	28	Input	SYSREF request for JESD204B support. Configurable to accept CMOS input (1.8-V to 3.3-V logic) or differential input.	
VbiasVARAC	33	Bypass	VCO Varactor bias. Connect a 10-μF decoupling capacitor to VCO ground.	
VbiasVCO	3	Bypass	VCO bias. Connect a 470-nF (X7R) decoupling capacitor to VCO ground as close to this pin as possible.	
VbiasVCO2	27	Bypass	VCO bias. Connect a 100-nF (X7R) decoupling capacitor to VCO ground.	
VccBUF	21	Supply	Supply for output buffers. Connect a 0.1-µF decoupling capacitor to RF ground.	
VccCP	11	Supply	Supply for charge pump. Connect a 0.1-µF decoupling capacitor to charge pump ground.	
VccDIG	7	Supply	Digital power supply. Connect a 0.1-µF decoupling capacitor to digital ground.	
VccMASH	15	Supply	Digital power supply. Connect a 1-µF decoupling capacitor to digital ground.	
VccVCO	37	Supply	Supply for VCO. Connect a 1-µF decoupling capacitor to VCO ground.	
VccVCO2	26	Supply	Supply for VCO. Connect a 1-µF decoupling capacitor to VCO ground.	
VrefVCO	36	Bypass	VCO supply reference. Connect a 10-µF decoupling capacitor to VCO ground.	
VrefVCO2	29	Bypass	VCO supply reference. Connect a 10-μF decoupling capacitor to VCO ground.	
VregIN	10	Bypass	Input reference path regulator output. Connect a 1-µF decoupling capacitor to RF ground as close to this pin as possible.	
VregVCO	38	Bypass	VCO regulator node. Connect a 10-nF decoupling capacitor to VCO ground.	
Vtune	35	Input	VCO tuning voltage input. Connect a 1.5-nF or more capacitor to VCO ground. See <i>External Loop Filter</i> for details.	

# 6 Specifications

# 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) (1)

		MIN	MAX	UNIT
$V_{CC}$	Power supply voltage	-0.3	3.6	V
$V_{IN}$	Digital IO input voltage		$V_{CC} + 0.3$	V
TJ	Junction temperature		150	°C
T <sub>stg</sub>	Storage temperature	-65	150	°C

<sup>(1)</sup> Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

# 6.2 ESD Ratings

			VALUE	UNIT
V	Electrostatio discharge	Human body model (HBM), per ANSI/ESDA/JEDEC JS-001, all pins <sup>(1)</sup>	±2000	V
V <sub>(ESD)</sub> Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101, all pins (2)	±500	V	

<sup>(1)</sup> JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

<sup>(2)</sup> JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



# 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

		MIN	NOM MAX	UNIT
T <sub>A</sub>	Ambient temperature	-40	85	°C
$T_{J}$	Junction temperature		125	°C

# 6.4 Thermal Information

		LMX2572	
	THERMAL METRIC <sup>(1)</sup>	RHA (VQFN)	UNIT
		40 PINS	
$R_{\theta JA}$	Junction-to-ambient thermal resistance	25.5	°C/W
$R_{\theta JC(top)}$	Junction-to-case (top) thermal resistance	14.4	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	8.0	°C/W
$\Psi_{JT}$	Junction-to-top characterization parameter	0.2	°C/W
$\Psi_{JB}$	Junction-to-board characterization parameter	7.9	°C/W
$R_{\theta JC(bot)}$	Junction-to-case (bottom) thermal resistance	1.2	°C/W

<sup>(1)</sup> For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

#### 6.5 Electrical Characteristics

 $3.0 \text{ V} \le \text{V}_{CC} \le 3.5 \text{ V}$ ,  $-40^{\circ}\text{C} \le \text{T}_{A} \le 85^{\circ}\text{C}$ . Typical values are at  $\text{V}_{CC} = 3.3 \text{ V}$ ,  $25^{\circ}\text{C}$  (unless otherwise noted)

	PARAMETER	TEST CONDITION	IS	MIN	TYP	MAX	UNIT	
POWER S	UPPLY							
V <sub>CC</sub>	Supply voltage			3	3.3	3.5	V	
		f <sub>PD</sub> = 20 MHz; I <sub>CPout</sub> = 1.25 mA	Direct VCO		75			
	Supply current	f <sub>PD</sub> = 100 MHz; I <sub>CPout</sub> = 2.5 mA	output <sup>(1)</sup>		79			
I <sub>CC</sub>	Зирріу сипепі	f <sub>PD</sub> = 20 MHz; I <sub>CPout</sub> = 1.25 mA	Divided down		82		mA	
		f <sub>PD</sub> = 100 MHz; I <sub>CPout</sub> = 2.5 mA	output <sup>(2)</sup>		86			
I <sub>CC</sub> PD	Power down current				2.5			
INPUT SIG	SNAL PATH							
4	OSCin input frequency	OSC_2X = 0 (Doubler bypassed)	)	5		250	NAL I-	
f <sub>OSCin</sub>	OSCIII input frequency	OSC_2X = 1 (Doubler enabled)	OSC_2X = 1 (Doubler enabled)			125	MHz	
\/	OSCin input voltage (3)	Single-ended input buffer		0.3		3.6	V	
$V_{OSCin}$	OSCIII input voitage V	Differential input buffer	Differential input buffer			1		
f <sub>MULTin</sub>	Multiplier input frequency	MULT ≥ 3		10		40	MHz	
f <sub>MULTout</sub>	Multiplier output frequency	WOLT 23		60		150	IVII IZ	
PLL								
		Integer channel		0.25		250		
	51 (4)	1 <sup>st</sup> and 2 <sup>nd</sup> order modulator		5		200	MHz	
f <sub>PD</sub>	Phase detector frequency <sup>(4)</sup>	3 <sup>rd</sup> order modulator		5		160		
		4 <sup>th</sup> order modulator		5		120		
		CPG = 1			625			
		CPG = 2			1250			
I <sub>CPout</sub>	Charge pump current	CPG = 3			1875		μΑ	
		CPG = 15 66		6875				

 $<sup>\</sup>begin{aligned} &f_{OSCin} = 100 \text{ MHz; } f_{VCO} = f_{OUT} = 6.4 \text{ GHz; } P_{OUT} = 0 \text{ dBm; } OSC\_2X = 0; \text{ MULT} = 1; \text{ one RF output.} \\ &f_{OSCin} = 100 \text{ MHz; } f_{VCO} = 6.4 \text{ GHz; } f_{OUT} = 3.2 \text{ GHz; } P_{OUT} = 0 \text{ dBm; } OSC\_2X = 0; \text{ MULT} = 1; \text{ one RF output.} \\ &See \underbrace{OSCin}_{Configuration} \text{ for definition of OSCin input voltage.} \end{aligned}$ 

For lower VCO frequencies, the N-divider minimum value can limit the phase detector frequency. (4)



# **Electrical Characteristics (continued)**

3.0 V  $\leq$  V<sub>CC</sub>  $\leq$  3.5 V,  $-40^{\circ}$ C  $\leq$  T<sub>A</sub>  $\leq$  85 $^{\circ}$ C. Typical values are at V<sub>CC</sub> = 3.3 V, 25 $^{\circ}$ C (unless otherwise noted)

	PARAMETER	TEST CONDITION	IS	MIN TYP	MAX	UNIT
PN <sub>PLL_1/f</sub>	Normalized PLL 1/f noise <sup>(5)</sup>			-123.5		
	Namedia d DLL maio floor(5)	Integer channel <sup>(6)</sup>		-232		dBc/Hz
PN <sub>PLL_Flat</sub>	Normalized PLL noise floor (5)	Fractional channel (7)		-232		
vco						
f <sub>VCO</sub>	VCO frequency			3200	6400	MHz
			10 kHz	-88		
		4 24015	100 kHz	-111		
PN <sub>VCO</sub> C		$f_{VCO} = 3.4 \text{ GHz}$	1 MHz	-131		
			10 MHz	-150		
		£ 20 CH-	10 kHz	-87.5		
			100 kHz	-111		
		$f_{VCO} = 3.9 \text{ GHz}$	1 MHz	-131.5		
			10 MHz	-150		
		f <sub>VCO</sub> = 4.4 GHz	10 kHz	-86.5		
	Open loop VCO phase noise		100 kHz	-111		dBc/Hz
			1 MHz	-131		
			10 MHz	-150		
		f <sub>VCO</sub> = 4.9 GHz	10 kHz	-85		
			100 kHz	-110		
			1 MHz	-130.5		
			10 MHz	-149.5		
		f <sub>VCO</sub> = 5.4 GHz	10 kHz	-84.5		
			100 kHz	-109		
			1 MHz	-129.5		
			10 MHz	-149		
		( 50 QU-	10 kHz	-84		
			100 kHz	-108.5		
		$f_{VCO} = 5.9 \text{ GHz}$	1 MHz	-129		
			10 MHz	-148		
		f <sub>VCO</sub> = 3.4 GHz		39		
		f <sub>VCO</sub> = 3.9 GHz		44		
<b>K</b>	VCO gain	f <sub>VCO</sub> = 4.4 GHz		55		MU-A
K <sub>VCO</sub>	VCO gain	f <sub>VCO</sub> = 4.9 GHz		60		MHz/V
		f <sub>VCO</sub> = 5.4 GHz		69		
		f <sub>VCO</sub> = 5.9 GHz		62		
			No assist	130		
t <sub>VCOcal</sub>	VCO calibration-time (8)	f <sub>OSCin</sub> = f <sub>PD</sub> = 100 MHz; Switch between 3.2 GHz and 6.4 GHz	Partial assist	50		μs
		55.770011 5.2 Of 12 and 0.4 Of 12	Full assist	5		
Δ <sub>TCL</sub>	Allowable temperature drift <sup>(9)</sup>	VCO not being re-calibrated, -40	0°C ≤ T <sub>A</sub> ≤ 85°C		125	°C

<sup>(5)</sup> Measured with a clean OSCin signal with a high slew rate using a wide loop bandwidth. The noise metrics model the PLL noise for an infinite loop bandwidth as: PLL\_Total = 10\*log[10<sup>(PLL\_Flat/10)</sup>+10<sup>(PLL\_Flicker/10)</sup>]; PLL\_Flat = PN1 Hz + 20\*log(N) + 10\*log(f<sub>PD</sub>); PLL\_Flicker = PN10 kHz - 10\*log(Offset/10 kHz) + 20\*log(f<sub>OUT</sub>/1 GHz)

 $f_{OSCin} = 200 \text{ MHz; } f_{PD} = 100 \text{ MHz; } f_{VCO} = f_{OUT} = 6 \text{ GHz}$   $f_{OSCin} = 200 \text{ MHz; } f_{PD} = 100 \text{ MHz; } f_{VCO} = f_{OUT} = 6.001 \text{ GHz; } Fractional denominator = 1000.$ (7)

See VCO Calibration for details.

Not tested in production. Ensured by characterization. Allowable temperature drift refers to programming the device at an initial temperature and allowing this temperature to drift WITHOUT reprogramming the device, and still have the device stay at lock. This change could be up or down in temperature and the specification does not apply to temperatures that go outside the recommended operating temperatures of the device.



# **Electrical Characteristics (continued)**

 $3.0 \text{ V} \le \text{V}_{\text{CC}} \le 3.5 \text{ V}$ ,  $-40^{\circ}\text{C} \le \text{T}_{\text{A}} \le 85^{\circ}\text{C}$ . Typical values are at  $\text{V}_{\text{CC}} = 3.3 \text{ V}$ ,  $25^{\circ}\text{C}$  (unless otherwise noted)

	PARAMETER	TEST CONDITION	S	MIN	TYP	MAX	UNIT
RF OUTPUT							
f <sub>OUT</sub>	RF output frequency			12.5		6400	MHz
P <sub>OUT</sub>	Single-ended output power	$f_{OUT} = 6.4GHz$			4.5		dBm
Un	Second harmonic	$f_{VCO} = f_{OUT} = 6.4 \text{ GHz}$			-20		
H2 <sub>OUT</sub>	Second narmonic	$f_{VCO} = 6.4 \text{ GHz}, f_{OUT} = 3.2 \text{ GHz}$	OUTx_PWR = 50		-37		dBc
Пэ	Third harmonic	$f_{VCO} = f_{OUT} = 6.4 \text{ GHz}$			-25		UDC
H3 <sub>OUT</sub>	Third narmonic	$f_{VCO} = 6.4 \text{ GHz}, f_{OUT} = 3.2 \text{ GHz}$			-13		
t <sub>skew</sub> CH	Channel to channel skew	f <sub>OUT</sub> = 3.2 GHz			14		ps
PHASE SYN	CHRONIZATION						
f CVNC	OSCin input frequency with	Category 3		5		100	MHz
f <sub>OSCin</sub> SYNC	SYNC	Categories 1 and 2		5		200	IVITIZ
t <sub>skew</sub> SYNC	OSCin to RFout skew	After phase synchronization; f <sub>OSCin</sub> SYNC = f <sub>OUT</sub> = 100 MHz			2		ns
DIGITAL INT	ERFACE	•		•		·	
V <sub>IH</sub>	High-level input voltage			1.4		$V_{CC}$	V
V <sub>IL</sub>	Low-level input voltage					0.4	V
I <sub>IH</sub>	High-level input current			-25		25	
I <sub>IL</sub>	Low-level input current			-25		25	μA
V <sub>OH</sub>	High-level output voltage	Load current = -5 mA	MI IVout nin	V <sub>CC</sub> - 0.5			V
V <sub>OL</sub>	Low-level output voltage	Load current = 5 mA	MUXout pin			0.5	V

# 6.6 Timing Requirements

 $3.0 \text{ V} \le V_{CC} \le 3.5 \text{ V}, -40 ^{\circ}\text{C} \le T_{A} \le 85 ^{\circ}\text{C}.$  Typical values are at  $V_{CC} = 3.3 \text{ V}, 25 ^{\circ}\text{C}$  (unless otherwise noted)

			MIN	NOM	MAX	UNIT
SERIA	INTERFACE WRITE TIMING	-				
f <sub>SCK</sub>	SCK frequency	1 / (t <sub>CWL</sub> + t <sub>CWH</sub> )			75	MHz
t <sub>CE</sub>	SCK to CSB low time		5			ns
t <sub>CS</sub>	SDI to SCK setup time		2			ns
t <sub>CH</sub>	SDI to SCK hold time		2			ns
t <sub>CWH</sub>	SCK pulse width high	Figure 1	5			ns
t <sub>CWL</sub>	SCK pulse width low		5			ns
t <sub>CES</sub>	CSB to SCK setup time		5			ns
t <sub>EWH</sub>	CSB pulse width high		2			ns
SERIAI	L INTERFACE READ TIMING					
$f_{SCK}$	SCK frequency	1 / (t <sub>CWL</sub> + t <sub>CWH</sub> )			50	MHz
t <sub>CE</sub>	SCK to CSB low time		10			ns
t <sub>CS</sub>	SDI to SCK setup time		10			ns
t <sub>CH</sub>	SDI to SCK hold time		10			ns
t <sub>CWH</sub>	SCK pulse width high	Figure 1	10			ns
t <sub>CWL</sub>	SCK pulse width low		10			ns
t <sub>CES</sub>	CSB to SCK setup time		10			ns
t <sub>EWH</sub>	CSB pulse width high		10			ns
SYNC	AND SYSREFREQ TIMING			·		
t <sub>CS</sub>	Pin to OSCin setup time	Figure 2	2.5			ns
t <sub>CH</sub>	Pin to OSCin hold time	Figure 2	2			ns



# 6.7 Timing Diagrams

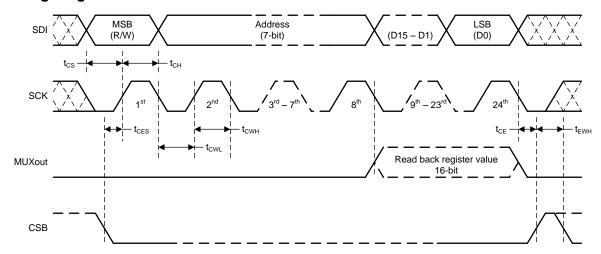


Figure 1. Serial Interface Timing Diagram

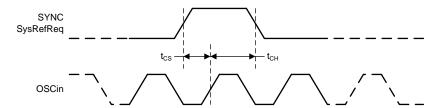


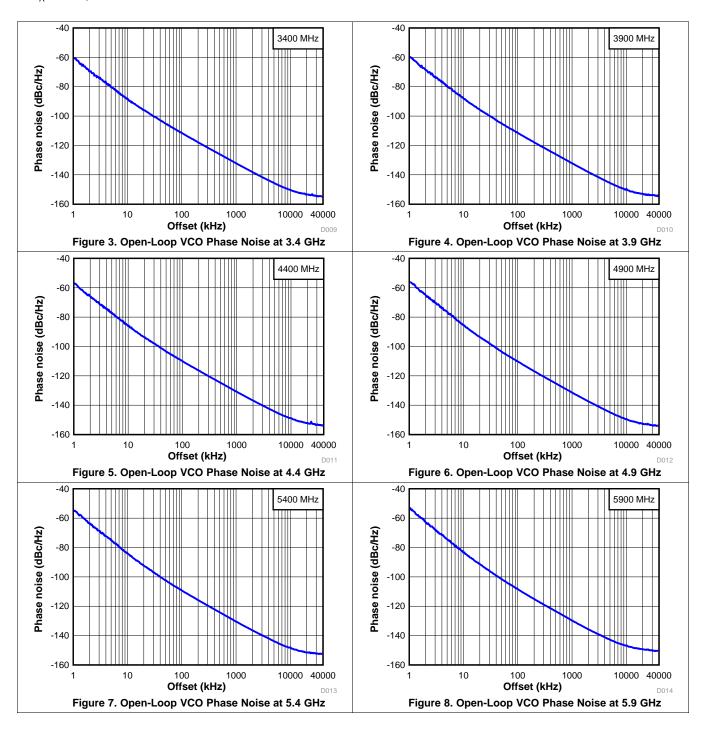
Figure 2. Trigger Signals Timing Diagram

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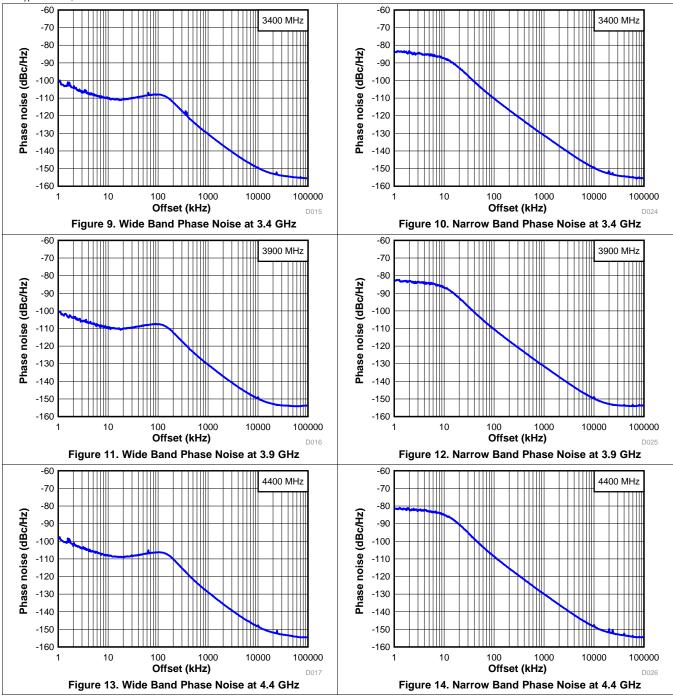
# 6.8 Typical Characteristics

At  $T_A = 25$ °C, unless otherwise noted





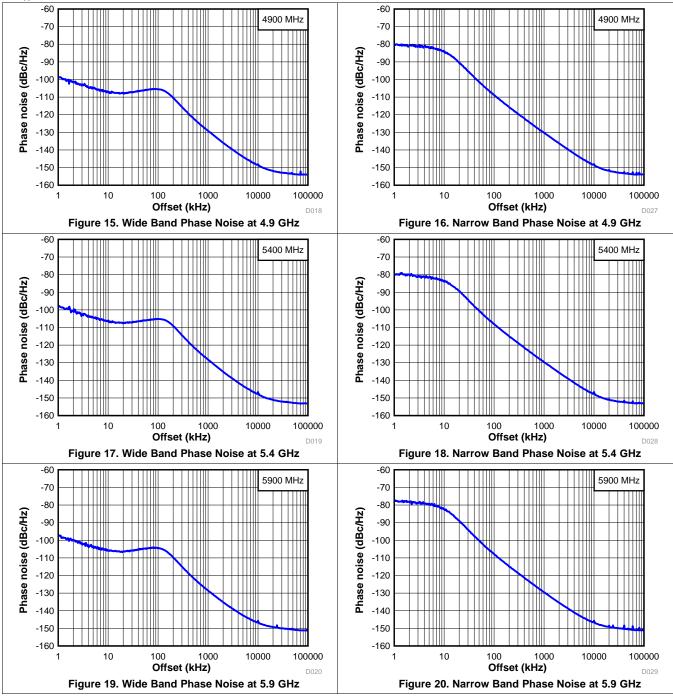
At  $T_A = 25$ °C, unless otherwise noted



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At  $T_A = 25$ °C, unless otherwise noted

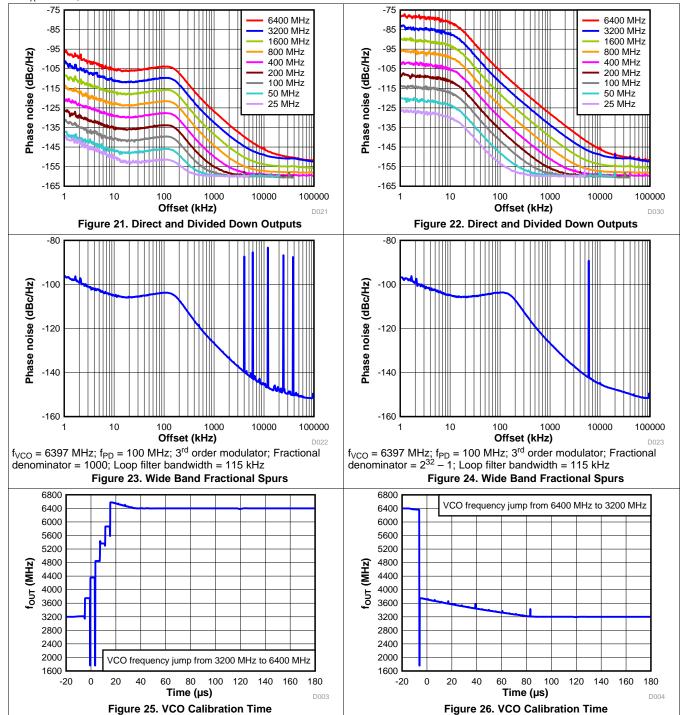


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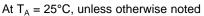


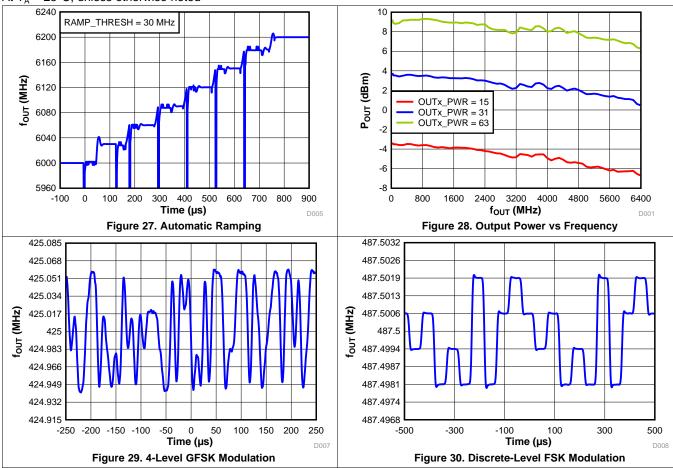
At  $T_A = 25$ °C, unless otherwise noted



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# 7 Detailed Description

#### 7.1 Overview

The LMX2572 is a low-power, high-performance, wideband frequency synthesizer with integrated VCO and output divider. The VCO operates from 3.2 to 6.4 GHz, and this can be combined with the output divider to produce any frequency in the range of 12.5 MHz to 6.4 GHz. Within the input path, there are two dividers and a multiplier for flexible frequency planning. The multiplier also allows reduction of spurs by moving the frequencies away from the integer boundary.

The PLL is a fractional-N PLL with a programmable delta-sigma modulator up to 4<sup>th</sup> order. The fractional denominator is a programmable 32-bit long that can supply fine frequency steps easily below the 1-Hz resolution. The denominator can also be used to do exact fractions like 1/3, 7/1000, and many others.

For applications where deterministic or adjustable phase is desired, the SYNC pin can be used to get the phase relationship between the OSCin and RFout pins deterministic. Once this is done, the phase can be adjusted in very fine steps of the VCO period divided by the fractional denominator.

The ultra-fast VCO calibration is ideal for applications where the frequency must be swept or abruptly changed. The frequency can be manually programmed, or the device can be set up to do ramps and chirps.

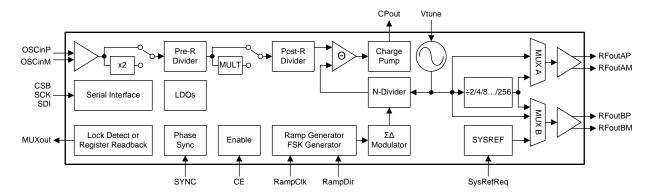
The JESD204B support includes using the RFoutB output to create a differential SYSREF output that can be either a single pulse, series of pulse, or a continuous stream of pulses. These pulses are synchronous with the RFoutA signal with an adjustable delay.

The FSK generator can support FSK generation in discrete 2-, 4-, or 8-level FSK, or it can any arbitrary level FSK making it ideal to support pulse-shaped FSK modulation such as GFSK.

The LMX2572 device requires only a single 3.3-V power supply and uses very low current. The internal power supplies are provided by integrated LDOs, eliminating the need for high performance external LDOs.

Digital logic interface is compatible with 1.8-V input. The user can program the device through the serial interface. The device can be powered down through register programming or by toggling the Chip Enable (CE) pin.

## 7.2 Functional Block Diagram



# 7.3 Feature Description

#### 7.3.1 Reference Oscillator Input

The OSCin pins are used as a frequency reference input to the device. The input is high impedance and requires AC-coupling capacitors at the pin. The OSCin pins can be driven single-ended with a CMOS clock, XO, or single-ended differential clock. Differential clock input is also supported, which makes the device easier to interface with high-performance system clock devices such as TI's LMK series clock devices. As the OSCin signal is used as a clock for the VCO calibration, a proper reference signal must be applied at the OSCin pin at the time of programming FCAL EN.



## **Feature Description (continued)**

#### 7.3.2 Reference Path

The reference path consists of an OSCin doubler (OSC\_2X), Pre-R divider (PLL\_R\_PRE), Multiplier (MULT), and a Post-R divider (PLL\_R).

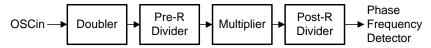


Figure 31. Reference Path

The Doubler allows one to double the input reference frequency up to 250 MHz. The Doubler adds minimal noise and is useful for raising the phase detector frequency for better phase noise. The Doubler can also be used to avoid spurs. The Doubler uses both the rising and falling edges of the input signal, so the input signal must have 50% duty cycle if the Doubler is enabled. Note that the Multiplier cannot be used if the Doubler is engaged.

The Pre-R divider can help reduce input frequency so that the Multiplier can be used and the maximum 200-MHz input frequency limitation of the Post-R divider can be met.

The Multiplier multiplies the frequency up under the allowable multiplications of 3, 4, 5, 6, and 7. In combination with the Pre-R and Post-R dividers, the Multiplier offers the flexibility to shift the phase detector frequency away from frequencies that may create integer boundary spurs with the VCO and the output frequencies. Be aware that unlike the Doubler, the Multiplier degrades the PLL figure of merit. This degradation would only matter, however, for a very clean reference oscillator input and if the loop bandwidth was wide. The user should not use the Doubler while using the Multiplier. The Multiplier is bypassed if its value is set to 1.

The Post-R divider can be used to further divide down the frequency to the phase detector frequency. When it is used (PLL\_R > 1), the input frequency to this divider is limited to 200 MHz.

Use Equation 1 to calculate the phase detector frequency, f<sub>PD</sub>.

$$f_{PD} = f_{OSCin} \times OSC_2X \times MULT / (PLL_R_PRE \times PLL_R)$$
(1)

Table 1 summarizes the usage boundaries of these functional blocks in the reference path.

**Table 1. Reference Path Boundaries** 

PARAMETER	VALUE	INF FREQI (M		FREQ	TPUT UENCY Hz)	NOTES
		MIN	MAX	MIN	MAX	
OSCin	N/A	5	250			
Doubler	0 (Bypassed), 1 (x2)	5	125	10	250	When OSC_2X = 1, Multiplier cannot be used at the same time.
Pre-R divider	1 (Bypassed), 2, 3,, 254, 255	5	200	0.25	200	Keep it equals 1 unless when necessary.
Multiplier	1 (Bypassed), 3, 4, 5, 6, 7	10	40	60	150	When the output frequency is greater than 100MHz, set MULT_HI = 1.
Post-R divider	1 (Bypass), 2, 3,, 254, 255	5	200	0.25	200	

## 7.3.3 PLL Phase Detector and Charge Pump

The phase detector compares the outputs of the Post-R divider and N divider and generates a correction current corresponding to the phase error until the two signals are aligned in phase. This charge-pump current is software programmable to many different levels, allowing modification of the closed-loop bandwidth of the PLL.

**Table 2. Charge Pump Gain** 

CGP	0	1	2	3	4 or 8	5 or 9	6 or 10	7 or 11	12	13	14	15	UNIT
Gain	Tri-state	625	1250	1875	2500	3125	3750	4375	5000	5625	6250	6875	μA



#### 7.3.4 PLL N Divider and Fractional Circuitry

The N divider includes fractional compensation and can achieve any fractional denominator (PLL\_DEN) from 1 to  $(2^{32}-1)$ . The integer portion of N (PLL\_N) is the whole part of the N divider value, and the fractional portion,  $N_{frac} = PLL_NUM / PLL_DEN$ , is the remaining fraction. PLL\_N, PLL\_NUM and PLL\_DEN are software programmable. The higher the denominator, the finer the resolution step of the output. For example, even when using  $f_{PD} = 200$  MHz, the output can increment in steps of 200 MHz /  $(2^{32}-1) = 0.0466$  Hz. Equation 2 shows the relationship between the phase detector and VCO frequencies. Note that in SYNC mode, there is an extra divider that is not shown in Equation 2.

$$f_{VCO} = f_{PD} \times [PLL_N + (PLL_NUM / PLL_DEN)]$$
 (2)

The multi-stage noise-shaping (MASH) sigma-delta modulator that controls the fractional division is also programmable from integer mode to fourth order. All of these settings work for integer channel where PLL\_NUM = 0. To make the fractional spurs consistent, the modulator is reset any time that the R0 register is programmed.

The N divider has minimum value restrictions based on the modulator order. Furthermore, the PFD\_DLY\_SEL bit must be programmed in accordance to Table 3.

VCO					MA	ASH ORDER				
FREQUENCY		INTEGER	FII	RST ORDER	SEC	OND ORDER	TH	IRD ORDER	FOL	JRTH ORDER
(GHz)	N	PFD_DLY_SEL	N	PFD_DLY_SEL	N	PFD_DLY_SEL	N	PFD_DLY_SEL	N	PFD_DLY_SEL
f <sub>VCO</sub> < 4	20	0	25	1	26	1	32	2	44	4
$4 \le f_{VCO} < 4.9$	24	1	29	2	30	2	32	2	44	4
$4.9 \le f_{VCO} \le 6.4$	24	1	29	2	30	2	36	3	48	5

**Table 3. Minimum N Divider Restrictions** 

#### 7.3.5 Voltage-Controlled Oscillator

The LMX2572 includes a fully integrated VCO. The VCO generates a frequency which varies with the tuning voltage from the loop filter. The entire VCO frequency range, 3.2 to 6.4 GHz, covers an octave that allows the channel divider to take care of frequencies below the lower bound.

To reduce the VCO tuning gain, thus improving the VCO phase noise performance, the VCO frequency range is divided into 6 different frequency bands. This creates the need for frequency calibration to determine the correct frequency band given in a desired output frequency. The VCO is also calibrated for amplitude to optimize phase noise. These calibration routines are activated any time that the R0 register is programmed with the FCAL\_EN bit equals one. It is important that a valid OSCin signal must present before VCO calibration begins. This device will support a full sweep of the valid temperature range of 125°C (–40°C to 85°C) without having to re-calibrate the VCO. This is important for continuous operation of the synthesizer under the most extreme temperature variation.

#### 7.3.6 Channel Divider

To go below the VCO lower bound of 3.2 GHz, the channel divider can be used. The channel divider consists of several segments, and the total division value is equal to the multiplication of them. Therefore, not all values are valid.

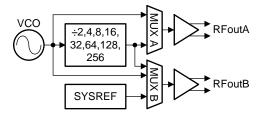


Figure 32. Channel Divider

The channel divider is automatically powered up whenever the MUXs have selected divided down output or SYSREF output, regardless of whether the RF output buffers are turned on or not. When an output is not used, TI recommends selecting the VCO output (OUTx\_MUX = 1) to ensure that the channel divider is not unnecessarily powered up.



#### Table 4. Channel Divider

OUTA_MUX	OUTB_MUX	CHANNEL DIVIDER
0: Channel divider output	Don't care	
Don't care	0: Channel divider output 2: SYSREF output	Powered up
All other	r cases	Powered down

#### 7.3.7 Output Buffer

The output buffers are differential push-pull type buffers, thus no external pullup to  $V_{CC}$  is required. The output impedance of the buffer is very small, and as such, the buffer can be AC-coupled to drive a 50- $\Omega$  load. Output power of the buffer can be programed to various levels. The buffer can be disabled while still keeping the PLL in lock. Buffer A supports direct VCO output or divided down output. Buffer B supports direct VCO output, divided down output or SYSREF output.

#### 7.3.8 Lock Detect

The MUXout pin can be configured to output a signal that gives an indication for the PLL being locked. If the MUXout pin is configured as a lock detect output (MUXOUT\_LD\_SEL = 1), the MUXout pin output is a logic HIGH voltage when the device is locked. When the device is unlocked, the MUXout pin output is a logic LOW voltage.

There are options to select the definition of PLL being locked. If LD\_TYPE = 0, lock detect asserts a HIGH output after the VCO has finished calibration and the LD\_DLY timeout counter is finished. If LD\_TYPE = 1, in addition to the VCO calibration and counter check, lock detect will assert a HIGH output if the VCO tuning voltage is also within an acceptable limits.

#### 7.3.9 Register Readback

The MUXout pin can also be configured to read back useful information from the device. Common uses for readback are:

- Read back registers to ensure that they have been programmed to the correct value. LMX2572 allows any of its registers to be read back.
- · Read back the lock detect status to determine if the PLL is in lock.
- Read back VCO calibration information so that it can be used to improve the lock time.

#### 7.3.10 Powerdown

The LMX2572 can be powered up and down using the CE pin or the POWERDOWN bit. All registers are preserved in memory while the device is powered down.

The wake-up time for the device to come out of the powered state is adjustable. See Power-Up, Wake-Up Time for details.

#### 7.3.11 Phase Synchronization

The SYNC pin allows the user to synchronize the LMX2572 such that the delay from the rising edge of th OSCin signal to the RF output signal is deterministic. Phase synchronization is especially useful if there are multiple LMX2572 devices in a system and it is desirable to have all the RF outputs aligned in phase.

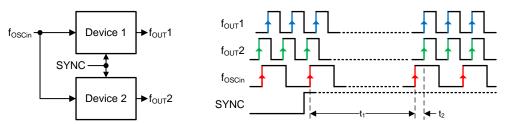


Figure 33. Phase Synchronization

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Initially, the devices are locked to the input but are not synchronized. The user sends a synchronization pulse that is re-clocked to the next rising edge of the OSCin pulse. After a given time,  $t_1$ , the devices are synchronized. This time is dominated by the sum of the VCO calibration time, the analog settling time of the PLL loop, and the MASH\_RST\_COUNT, if used in fractional mode. After synchronization, both devices will have a deterministic delay of  $t_2$ , related to OSCin.

#### 7.3.12 Phase Adjustment

The LMX2572 can use the sigma-delta modulator to adjust the output signal phase with respect to the input reference. The phase shift every time you write the value of MASH\_SEED is Equation 3:

Phase shift in degree = 360° x (MASH\_SEED / PLL\_DEN) x (P / CHDIV)

where

For example, if

- MASH SEED = 800
- PLL\_DEN = 1000
- CHDIV = 32
- VCO\_PHASE\_SYNC\_EN = 0

Phase shift =  $360^{\circ} \times (800 / 1000) \times (1 / 32) = 9^{\circ}$ . If we write 800 to MASH\_SEED 40 times, then we will shift the phase by  $360^{\circ}$ .

There are a couple of restrictions when using phase adjustment:

- Phase adjustment does not work with MASH ORDER equals 0 (Integer mode) or 1 (First order).
- Phase adjustment is possible with integer channels (PLL\_NUM = 0) as long as MASH\_ORDER is greater than 1.
- PLL DEN must be greater than PLL NUM + MASH SEED.

#### 7.3.13 Ramping Function

The LMX2572 supports the ability to make frequency ramping waveforms using manual mode or automatic mode.

In manual ramping mode, the user defines a step and uses the RampClk and RampDir pins to create the ramp. The output frequency jumps from one frequency to another frequency on each ramp.

In automatic ramping mode, the user sets up the ramp with up to two linear segments in advance and the device automatically creates this ramp. The output waveform is a continuous frequency sweep between the start and end frequencies. If the frequency ramping range is small (approximately 10 MHz), no VCO calibration break is necessary in the middle of the ramp.

When using ramp, the following must be set accordingly:

- Phase detector frequency must be between  $f_{OSCin}$  /  $2^{CAL\_CLK\_DIV}$  and 125 MHz.
- OUT FORCE = 1 to force the RF outputs not to be automatically muted during VCO calibration.
- LD\_DLY = 0 to avoid interfering with VCO calibration.
- PLL\_DEN =  $2^{32}$  1. The actual denominator value being used in ramping mode is  $2^{24}$ .

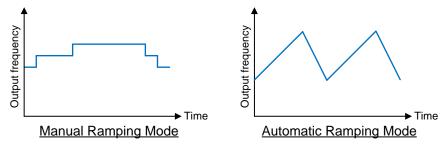


Figure 34. Ramping Modes



#### 7.3.14 SYSREF

RFoutB of LMX2572 can be used to generate or duplicate SYSREF signal. The output of RFoutB can be a single pulse, series of pulse, or a continuous stream of pulses. These pulses are synchronous with the RFoutA signal with an adjustable delay. To use the SYSREF capability, the PLL must be in SYNC mode with VCO\_PHASE\_SYNC\_EN = 1. SYSREF output is triggered when there is a  $0 \rightarrow 1$  transition at the SysRefReq pin. In SYSREF Pulsed mode, a maximum of 15 consecutive pulses can be generated at a time.

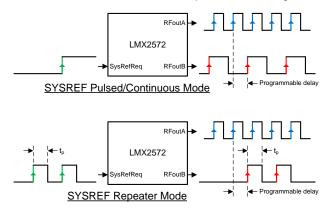


Figure 35. SYSREF Modes

#### 7.3.15 FSK Modulation

Direct digital FSK modulation is supported in LMX2572. FSK modulation is achieved by changing the output frequency by changing the N divider value. The LMX2572 supports two different types of FSK operation.

- FSK SPI mode. This mode supports discrete 2-, 4- and 8-level FSK modulation. There are eight dedicated registers used to pre-store the desired FSK frequency deviations. Program FSK\_SPI\_DEV\_SEL to select one of the FSK deviations at a time.
- 2. FSK SPI FAST mode. In this mode, instead of selecting one of the pre-stored FSK deviations, change the FSK deviation directly by writing to FSK\_SPI\_FAST\_DEV. As a result, this mode supports arbitrary-level FSK, which is useful to construct pulse-shaping or analog-FM modulation.

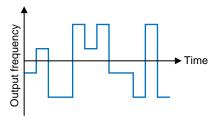


Figure 36. FSK Modulation

#### 7.4 Device Functional Modes

Table 5 lists the device functional modes of the LMX2572.

**Table 5. Device Functional Modes** 

MODE	DESCRIPTION
Normal operation mode	The device is used as a high frequency signal source without any addition features.
FSK mode	Generates discrete-level FSK or arbitrary-level pulse-shaped FSK modulation.
SYNC mode	This mode is used to ensure deterministic phase between OSCin and RFout.
SYSREF mode	The device is used as a JESD204B SYSREF clock generator or repeater.
Ramping mode	Automatic frequency sweeping without the need of continuous SPI programming.



## 7.5 Programming

The LMX2572 is programmed using several 24-bit shift registers. The shift register consists of a data field, an address field, and a R/W bit. The MSB is the R/W bit. 0 means register write while 1 means register read. The following seven bits, ADDR[6:0], form the address field which is used to decode the internal register address. The remaining 16 bits form the data field DATA[15:0]. Serial data is shifted MSB first into the shift register. See Figure 1 for timing diagram details.

#### To write registers:

- The R/W bit must be set to 0.
- The data on SDI pin is clocked into the shift register upon the rising edge of the clocks on SCK pin. On the rising edge of the 24<sup>th</sup> clock cycle, the data is transferred from the data field into the selected register bank.
- The CSB pin may be held high after programming, which causes the LMX2572 to ignore clock pulses.
- If the SCK and SDI lines are toggled while the VCO is in lock, as is sometimes the case when these lines are shared between devices, the phase noise may be degraded during the time of this programming.

#### To read back registers:

- The R/W bit must be set to 1.
- The data field contents on the SDI line are ignored.
- The read back data on MUXout pin is clocked out starting from the falling edge of the 8<sup>th</sup> clock cycle.

## 7.5.1 Recommended Initial Power-On Programming

#### 7.5.1.1 Programming Sequence

When the device is first powered up, it must be initialized, and the ordering of this programming is important. The sequence is listed below. After this sequence is completed, the device should be running and locked to the proper frequency.

- 1. Apply power to the device and ensure all the supply pins are at the proper levels.
- 2. If CE is low, pull it high.
- 3. Wait 500 µs for the internal LDOs to become stable.
- 4. Ensure that a valid reference clock is applied to the OSCin pins.
- 5. Program register R0 with RESET = 1. This will ensure all the registers are reset to their default values. This bit is self-clearing.
- 6. Program in sequence registers R125, R124, R123, ..., R1 and then R0.

#### 7.5.1.2 Programming Register

There are altogether 126 programmable registers. However, not every register is required to be programmed at initial power-on.

For example, most of the registers have fixed field value which is also equal to their silicon default value. After programming R0 with RESET = 1, these register fields have returned to their silicon default values. As such, it is not necessary to program these registers again. Similarly, for those registers having configurable fields, if the desired field values are equal to the silicon default values, again it is not necessary to program these registers again after programming R0 with RESET = 1.

In Table 6, Depends means it is up to the user's decision of whether programming the register or not based upon the application need.

**Table 6. Suggested Register Programming** 

REGISTER	PROGRAM										
0	Yes	21	No	42	Yes	63	No	84	Depends	105	Depends
1	Depends	22	No	43	Yes	64	No	85	Depends	106	Depends
2	No	23	No	44	Depends	65	No	86	Depends	107	No
3	No	24	No	45	Depends	66	No	87	No	108	No
4	No	25	No	46	Depends	67	No	88	No	109	No
5	Depends	26	No	47	No	68	No	89	No	110	No
6	Depends	27	No	48	No	69	Depends	90	No	111	No



# **Programming (continued)**

#### Table 6. Suggested Register Programming (continued)

REGISTER	PROGRAM										
7	Depends	28	No	49	No	70	Depends	91	No	112	No
8	Depends	29	Yes	50	No	71	Yes	92	No	113	No
9	Depends	30	Yes	51	No	72	Depends	93	No	114	Depends
10	Depends	31	No	52	Yes	73	Depends	94	No	115	Depends
11	Depends	32	No	53	No	74	Depends	95	No	116	Depends
12	Depends	33	No	54	No	75	Depends	96	Depends	117	Depends
13	No	34	Depends	55	No	76	No	97	Depends	118	Depends
14	Depends	35	No	56	No	77	No	98	Depends	119	Depends
15	No	36	Yes	57	Yes	78	Yes	99	Depends	120	Depends
16	Depends	37	Yes	58	Depends	79	Depends	100	Depends	121	Depends
17	Depends	38	Yes	59	Depends	80	Depends	101	Depends	122	Depends
18	No	39	Yes	60	Depends	81	Depends	102	Depends	123	Depends
19	Depends	40	Depends	61	No	82	Depends	103	Depends	124	Depends
20	Depends	41	Depends	62	Depends	83	Depends	104	Depends	125	No

#### 7.5.2 Recommended Sequence for Changing Frequencies

The recommended sequence for changing frequencies in different scenarios is as follows:

- 1. If the N divider is changing, program the relevant registers and then program R0 with FCAL\_EN = 1.
- 2. In FSK and Ramp mode, the fractional numerator is changing; program the relevant registers only.

## 7.5.3 Double Buffering

Some register fields support double buffering. That is, the change to these fields would not be effective immediately. To latch the new values into the device requires programming R0 again with FCAL\_EN = 1. The following register fields support double buffering, see Table 70 for details.

- MASH order (MASH\_ORDER)
- Fractional numerator (PLL\_NUM)
- N divider (PLL N)
- Doubler (OSC\_2X); Pre-R divider (PLL\_R\_PRE); Multiplier (MULT); Post-R divider (PLL\_R)

For example,

- 1. Program PLL\_R and PLL\_N to new values. If double buffering for these fields is enabled, the PLL will remain unchanged.
- 2. Program R0 with FCAL EN = 1. The PLL will calibrate and lock using the new PLL R and PLL N values.

## 7.5.4 Block Programming

In a register write sequence, instead of sending 24 bits (one W/R bit, seven address bits, and 16 data bits) of payload for each register (with Block Programming), only the first register write requires the W/R bit and the address bits. The succeeding registers require sending only the 16-bit of data. However, the succeeding registers must be in descending order. For example, if the first register is R20, then all 24 bits of payload must be sent for R20. The next register must be R19, but only the 16-bit data is required. The programming sequence is as follows:

- 1. Pull CSB pin LOW.
- Write 0x14aaaa for R20.
- 3. Write 0xbbbb for R19, followed by 0xcccc for R18, and so on.
- 4. After the last register write is completed, pull CSB pin HIGH to finish Block Programming.

Since there is no CSB pulse between each register, the 16-bit of data field of each register can be sent immediately after the previous one.



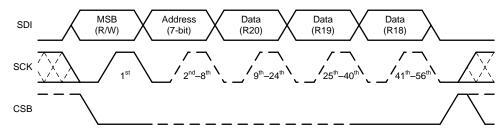


Figure 37. Block Programming Timing Example

Block Programming applies to both register write and read.



# 7.6 Register Maps

DEC								DATA[15	:0]								POR
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R0	RAMP_EN	VCO_PHASE_ SYNC_EN	1	0	ADD_HOLD	0	OUT_MUTE	FCAL_H	PFD_ADJ	FCAL_L	PFD_ADJ	1	FCAL_EN	MUXOUT_ LD_SEL	RESET	POWER DOWN	00221Ch
R1	0	0	0	0	1	0	0	0	0	0	0	0	1		CAL_CLK_D	IV	010808h
R2	0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0	020500h
R3	0	0	0	0	0	1	1	1	1	0	0	0	0	0	1	0	030782h
R4	0	0	0	0	1	0	1	0	0	1	0	0	0	0	1	1	040A43h
R5	0	0	1	IPBUF_ TYPE	IPBUF_ TERM	0	0	0	1	1	0	0	1	0	0	0	0530C8h
R6		LC	OO_DLY			0	0	0	0	0	0	0	0	0	1	0	06C802h
R7	0	OUT_ FORCE	0	0	0	0	0	0	1	0	1	1	0	0	1	0	0700B2h
R8	0	VCO_ DACISET_ FORCE	1	0	VCO_ CAPCTRL_ FORCE	0	0	0	0	0	0	0	0	0	0	0	082000h
R9	0	MULT_HI	0	OSC_2X	0	0	0	0	0	0	0	0	0	1	0	0	090004h
R10	0	0	0	1			MULT			1	1	1	1	0	0	0	0A10F8h
R11	1	0	1	1				PLL_	R				1	0	0	0	0BB018h
R12	0	1	0	1						PLL	_R_PRE						0C5001h
R13	0	1	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0D4000h
R14	0	0	0	1	1	0	0	0	0		(	CPG		0	0	0	0E1840h
R15	0	0	0	0	0	1	1	0	0	0	0	0	1	1	1	0	0F060Eh
R16	0	0	0	0	0	0	0					VCO_DA	CISET				100080h
R17	0	0	0	0	0	0	0					VCO_DACIS	ET_STRT				110096h
R18	0	0	0	0	0	0	0	0	0	1	1	0	0	1	0	0	120064h
R19	0	0	1	0	0	1	1	1				VC	O_CAPCTRL				1327B7h
R20	0	1		VCO_SE	L	VCO_SEL_ FORCE	0	0	0	1	0	0	1	0	0	0	143048h
R21	0	0	0	0	0	1	0	0	0	0	0	0	1	0	0	1	150409h
R22	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	160001h
R23	0	0	0	0	0	0	0	0	0	1	1	1	1	1	0	0	17007Ch
R24	0	0	0	0	0	1	1	1	0	0	0	1	1	0	1	0	18071Ah
R25	0	0	0	0	0	1	1	0	0	0	1	0	0	1	0	0	190624h
R26	0	0	0	0	1	0	0	0	0	0	0	0	1	0	0	0	1A0808h
R27	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	1B0002h
R28	0	0	0	0	0	1	0	0	1	0	0	0	1	0	0	0	1C0488h
R29	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1D18C6h
R30	0	0	0	1	1	0	0	0	1	0	1	0	0	1	1	0	1E18C6h
R31	1	1	0	0	0	0	1	1	1	1	1	0	0	1	1	0	1FC3E6h
R32	0	0	0	0	0	1	0	1	1	0	1	1	1	1	1	1	2005BFh
R33	0	0	0	1	1	1	1	0	0	0	0	0	0	0	0	1	211E01h
R34	0	0	0	0	0	0	0	0	0	0	0	1	0		PLL_N[18:16	6]	220010h

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# **Register Maps (continued)**

REG.								DATA[1	5:0]								DOD
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R35	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0	230004h
R36								PLL_N	1								240028h
R37	MASH_ SEED_EN	0			PFD_	DLY_SEL			0	0	0	0	0	1	0	1	250205h
R38								PLL_DEN[	31:16]					1			26FFFF
R39								PLL_DEN[	15:0]								27FFFF
R40								MASH_SEE	0[31:16]								280000
R41								MASH_SEE	D[15:0]								290000
R42								PLL_NUM[	31:16]								2A0000
R43								PLL_NUM	[15:0]								2B0000l
R44	0	0			тио	A_PWR			OUTB_ PD	OUTA_ PD	MASH_ RESET_N	0	0		MASH_ORE	DER	2C22A2
R45	1	1	0	TUO	ΓA_MUX	1	1	0	0	0			OU	JTB_PWR			2DC622
R46	0	0	0	0	0	1	1	1	1	1	1	1	0	0	OL	JTB_MUX	2E07F0
R47	0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0	2F0300h
R48	0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0	3003E0H
R49	0	1	0	0	0	0	0	1	1	0	0	0	0	0	0	0	314180h
R50	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	320080h
R51	0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0	330080h
R52	0	0	0	0	0	1	0	0	0	0	1	0	0	0	0	1	340420h
R53	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	350000h
R54	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	3600001
R55	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	370000h
R56	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	380000h
R57	0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0	390000h
R58	INPIN_ IGNORE	INPIN_ HYST	INPIN	N_LVL		INPIN_FMT		0	0	0	0	0	0	0	0	1	3A8001h
R59	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LD_TYPE	3B0001h
R60								LD_DL	Y				•				3C03E8
R61	0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0	3D00A8I
R62	DBLBUF_ EN_5	DBLBUF_ EN_4	DBLBUF_ EN_3	DBLBUF_ EN_2	DBLBUF_ EN_1	DBLBUF_ EN_0	0	0	1	0	1	0	1	1	1	1	3E00AF
R63	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	3F0000h
R64	0	0	0	1	0	0	1	1	1	0	0	0	1	0	0	0	401388
R65	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	410000h
R66	0	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	4201F4
R67	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	4300001
R68	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0	4403E8H
R69							MAS	SH_RST_CO	UNT[31:16]								450000h
R70	·						MA	SH_RST_CC	OUNT[15:0]							<del></del>	46C350h

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# **Register Maps (continued)**

								DATA[15	:0]								
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R71	0	0	0	0	0	0	0	0	SY	YSREF_DIV_	PRE	SYSREF_ PULSE	SYSREF_ EN	SYSREF_ REPEAT	0	1	470080
R72	0	0	0	0	0				•		SYSREF_D	ΝV					480001
R73	0	0	0	0			JESD_DAC2_	CTRL					JESD_	DAC1_CTRL			49003
R74		SYSREF_PULS	SE_CNT	1			JESD_DAC4_	CTRL					JESD_	DAC3_CTRL			4A000
R75	0	0	0	0	1			CHDIV			0	0	0	0	0	0	4B080
R76	0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0	4C000
R77	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	4D000
R78	0	0	0	0	RAMP_ THRESH[32]	0	QUICK_ RECAL_EN				VCO_CAF	PCTRL_STR	Г			1	4E006
R79							RA	MP_THRES	H[31:16]								4F000
R80							R.A	MP_THRES	SH[15:0]								500000
R81	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	RAMP_LIMIT_ HIGH[32]	510000
R82							RAM	P_LIMIT_HI	GH[31:16]								52000
R83		RAMP_LIMIT_HIGH[15:0]													53000		
R84	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	RAMP_LIMIT_ LOW[32]	54000
R85			•	•			RAM	IP_LIMIT_LO	DW[31:16]	*			•				55000
R86							RAN	/IP_LIMIT_L	OW[15:0]								56000
R87	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	57000
R88	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	58000
R89	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	59000
R90	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5A000
R91	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5B000
R92	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5C000
R93	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5D000
R94	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5E000
R95	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	5F000
R96	RAMP_ BURST_EN				·		RAMP_BL	JRST_COU	NT						0	0	60000
R97	RAMP0_RST	0	0	0	0		RAMP_TF	RIGB			RAMP	_TRIGA		0	RAMP	_BURST_TRIG	61000
R98							RAMP0_INC[29:	16]							0	RAMP0_DLY	62000
R99							ı	RAMP0_INC	[15:0]								63000
R100								RAMP0_L	.EN								64000
R101	0	0	0	0	0	0	0	0	0	RAMP1_ DLY	RAMP1_ RST	RAMP0_ NEXT	0	0	RAMP	0_NEXT_TRIG	65000
R102	0	0							RAMP1	I_INC[29:16]							66000
R103							I	RAMP1_INC	[15:0]								67000
R104								RAMP1_L	.EN								68000



# **Register Maps (continued)**

DEO								DATA[15	:0]								DOD
REG.	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	POR
R105					RAMP_DLY	_CNT					RAMP_ MANUAL	RAMP1_ NEXT	0	0	RAMP1	_NEXT_TRIG	694440h
R106	0	0	0	0	0	0	0	0	0	0	0	RAMP_ TRIG_CAL	0	RAM	MP_SCALE_0	COUNT	6A0007h
R107	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	6B0000h
R108	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	6C0000h
R109	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	6D0000h
R110	0	0	0	0	0	rb_LD_	VTUNE	0		rb_VCO_SE	L	0	0	0	0	0	6E0000h
R111	0	0	0	0	0	0	0	0				rb_VC0	_CAPCTRL				6F0000h
R112	0	0	0	0	0	0	0					rb_VCO_DAG	CISET				700000h
R113	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	710000h
R114	0	1	1	1	1	FSK_EN	0	0	0	FSK_SI	PI_LEVEL	FSF	C_SPI_DEV_S	SEL	FSK_	MODE_SEL	727800h
R115	0	0	0	0	0	0	0	0		I	FSK_DEV_SC	CALE		0	0	0	730000h
R116								FSK_DE	V0								740000h
R117								FSK_DE	V1								750000h
R118								FSK_DE	V2								760000h
R119								FSK_DE	V3								770000h
R120								FSK_DE	V4								780000h
R121								FSK_DE	V5								790000h
R122								FSK_DE	V6								7A0000h
R123			<u>-</u>	<u>-</u>				FSK_DE	V7	<u>-</u>	<u>-</u>		<u>-</u>	·	<u>-</u>		7B0000h
R124							F	SK_SPI_FAS	ST_DEV								7C0000h
R125	0	0	1	0	0	0	1	0	1	0	0	0	1	0	0	0	7D2288h

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Table 7 lists the access codes for the LMX2572 registers.

# **Table 7. Access Type Codes**

ACCESS TYPE	CODE	DESCRIPTION
Read Type		
R	R	Read
Write Type	•	
W	W	Write
Reset or Default	Value	
-n		Value after reset

# 7.6.1 Register R0 (offset = 00h) [reset = 221Ch]

# Figure 38. Register R0

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_E N	VCO_PH ASE_SY NC_EN	1	0	ADD_HO LD	0	OUT_MU TE	FCAL_HPFD_	ADJ	FCAL_LF	PFD_ADJ	1	FCAL_E N	MUXOU T_LD_S EL	RESET	POWER DOWN
R/W-0h	R/W-0h	R/W	/-2h	R/W-0h	R/W-0h	R/W-1h	R/W-0h		R/V	/-0h	R/W-1h	R/W-1h	R/W-1h	R/W-0h	R/W-0h

# **Table 8. Register R0 Field Descriptions**

Bit	Field	Туре	Reset	Description
15	RAMP_EN	R/W	Oh	Enables frequency ramping. The action of programming register R0 with RAMP_EN = 1 starts the ramping. Be aware that this is in the same register as FCAL_EN, so toggling this bit also can active the ramping if RAMP_EN = 1. RAMP_EN applies to both automatic and manual ramping modes.  0: Normal operation 1: Starts frequency ramping
14	VCO_PHASE_SYNC_EN	R/W	0h	Enables phase sync mode. In this state, part of the channel divider is put in the feedback path to ensure deterministic phase. The action of toggling this bit from 0 to 1 also sends an asynchronous SYNC pulse.  0: Normal operation 1: Phase sync mode
13 - 12		R/W	2h	Program 2h to this field.
11	ADD_HOLD	R/W	0h	Freeze the register address in Block Programming. See Block Programming for details.
10		R/W	0h	Program 0h to this field.
9	OUT_MUTE	R/W	1h	Mutes RF outputs (RFoutA and RFoutB) when the VCO is calibrating. 0: Disabled 1: Muted
8 - 7	FCAL_HPFD_ADJ	R/W	Oh	Set this field in accordance to the phase detector frequency for optimal VCO calibration. 0: $f_{PD} \le 37.5$ MHz 1: 37.5 MHz $< f_{PD} \le 75$ MHz 2: 75 MHz $< f_{PD} \le 100$ MHz 3: $f_{PD} > 100$ MHz
6 - 5	FCAL_LPFD_ADJ	R/W	Oh	Set this field in accordance to the phase detector frequency for optimal VCO calibration. 0: $f_{PD} \ge 10$ MHz 1: $10$ MHz > $f_{PD} \ge 5$ MHz 2: $5$ MHz > $f_{PD} \ge 2.5$ MHz 3: $f_{PD} \ge 2.5$ MHz
4		R/W	1h	Program 1h to this field.
3	FCAL_EN	R/W	1h	Enables and activates VCO frequency calibration. Writing register R0 with this bit set to a 1 enables and triggers the VCO frequency calibration. Writing 0 to this field is prohibited.  0: Invalid 1: Enabled



# Table 8. Register R0 Field Descriptions (continued)

Bit	Field	Туре	Reset	Description
2	MUXOUT_LD_SEL	R/W		Selects the functionality of the MUXout pin. 0: Register readback 1: Lock detect
1	RESET	R/W	0h	Resets all registers to silicon default values. This bit is self-clearing.  0: Normal operation  1: Reset
0	POWERDOWN	R/W	0h	Powers down the device. 0: Normal operation 1: Power down

# 7.6.2 Register R1 (offset = 01h) [reset = 0808h]

# Figure 39. Register R1

15	14	13	12	11	10	9	8	7	6	5	4	3	2	2 1		
0	0	0	0	1	0	0	0	0	0	0	0	1	C	V		
		R/W-101h												R/W-0h		

# Table 9. Register R1 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 3		R/W	101h	Program 101h to this field.
2 - 0	CAL_CLK_DIV	R/W	Oh	Divides down the state machine clock during VCO calibration. Maximum state machine clock frequency is 200 MHz. State machine clock frequency = $f_{OSCin} / (2^{CAL\_CLK\_DIV})$ . 0: $f_{OSCin} \le 200$ MHz 1: 200 MHz $< f_{OSCin} \le 250$ MHz All other values are not used.

# 7.6.3 Register R2 (offset = 02h) [reset = 0500h]

# Figure 40. Register R2

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	1	0	0	0	0	0	0	0	0
							R/W-	500h						•	

# **Table 10. Register R2 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 0		R/W	500h	Program 500h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.4 Register R3 (offset = 03h) [reset = 0782h]

# Figure 41. Register R3

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	1	1	0	0	0	0	0	1	0
							R/W-	782h							

# **Table 11. Register R3 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 0		R/W	782h	Program 782h to this field.
				After programming R0 with RESET = 1, no need to program this register.



# 7.6.5 Register R4 (offset = 04h) [reset = 0A43h]

# Figure 42. Register R4

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	1	0	0	1	0	0	0	0	1	1
	R/W-A43h														

# **Table 12. Register R4 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 0		R/W	A43h	Program A43h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.6 Register R5 (offset = 05h) [reset = 30C8h]

# Figure 43. Register R5

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	IPBUF_T YPE	IPBUF_T ERM	0	0	0	1	1	0	0	1	0	0	0
	R/W-1h		R/W-1h	R/W-0h						R/W-C8h					

# Table 13. Register R5 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 13		R/W	1h	Program 1h to this field.
12	IPBUF_TYPE	R/W	1h	Selects OSCin input type. 0: Differential input 1: Single-ended input
11	IPBUF_TERM	R/W	0h	Enables internal 50-Ω terminations on both OSCin and OSCin* pins. This function is valid even if OSCin input is configured as single-ended input.  0: Normal operation  1: OSCin and OSCin* pins are internally 50-Ω terminated
10 - 0		R/W	C8h	Program C8h to this field.

# 7.6.7 Register R6 (offset = 06h) [reset = C802h]

# Figure 44. Register R6

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
		LDO_DLY			0	0	0	0	0	0	0	0	0	1	0
		R/W-19h			•		•			R/W-2h					

# Table 14. Register R6 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 11	LDO_DLY	R/W		LDO start up delay. Delay duration is a function of state machine clock. See Power-Up, Wake-Up Time for details.
10 - 0		R/W	2h	Program 2h to this field.



# 7.6.8 Register R7 (offset = 07h) [reset = 00B2h]

# Figure 45. Register R7

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	OUT_FO RCE	0	0	0	0	0	0	1	0	1	1	0	0	1	0
R/W-0h	R/W-0h							R/W	-B2h						

# **Table 15. Register R7 Field Descriptions**

Bit	Field	Туре	Reset	Description
15		R/W	0h	Program 0h to this field.
14	OUT_FORCE	R/W		Forces the RF outputs not to be automatically muted during VCO calibration. This bit should be enabled during frequency ramping.  0: Mute setting depends on OUT_MUTE  1: No mute during VCO calibration
13 - 0		R/W	B2h	Program B2h to this field.

# 7.6.9 Register R8 (offset = 08h) [reset = 2000h]

# Figure 46. Register R8

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	VCO_DA CISET_F ORCE	1	0	VCO_CA PCTRL_ FORCE	0	0	0	0	0	0	0	0	0	0	0
R/W-0h	R/W-0h	R/V	V-2h	R/W-0h						R/W-0h					

# **Table 16. Register R8 Field Descriptions**

Bit	Field	Туре	Reset	Description
15		R/W	0h	Program 0h to this field.
14	VCO_DACISET_FORCE	R/W	0h	Forces VCO_DACISET value. Useful for fully-assisted VCO calibration and debugging purposes.  0: Normal operation  1: Use VCO_DACISET value instead of the value obtained from VCO calibration
13 - 12		R/W	2h	Program 2h to this field.
11	VCO_CAPCTRL_FORCE	R/W	0h	Forces VCO_CAPCTRL value. Useful for fully-assisted VCO calibration and debugging purposes.  0: Normal operation  1: Use VCO_CAPCTRL value instead of the value obtained from VCO calibration
10 - 0		R/W	0h	Program 0h to this field.



# 7.6.10 Register R9 (offset = 09h) [reset = 0004h]

# Figure 47. Register R9

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	MULT_H I	0	OSC_2X	0	0	0	0	0	0	0	0	0	1	0	0
R/W-0h	R/W-0h	R/W-0h	R/W-0h						R/V	/-4h					

#### **Table 17. Register R9 Field Descriptions**

Bit	Field	Туре	Reset	Description
15		R/W	0h	Program 0h to this field.
14	MULT_HI	R/W	0h	Sets this bit to 1 if the output frequency of the Multiplier is greater than 100 MHz. 0: Multiplier output ≤ 100 MHz 1: Multiplier output > 100 MHz
13		R/W	0h	Program 0h to this field.
12	OSC_2X	R/W	0h	Enables reference path Doubler. 0: Disabled 1: Enabled
11 - 0		R/W	4h	Program 4h to this field.

# 7.6.11 Register R10 (offset = 0Ah) [reset = 10F8h]

# Figure 48. Register R10

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1			MULT			1	1	1	1	0	0	0
	R/W	/-1h				R/W-1h						R/W-78h			

# **Table 18. Register R10 Field Descriptions**

				•
Bit	Field	Туре	Reset	Description
15 - 12		R/W	1h	Program 1h to this field.
11 - 7	MULT	R/W	1h	Reference path frequency Multiplier. Input frequency to the Multiplier: 10 to 40 MHz. Multiplier output frequency: 60 to 150 MHz. 0: Not used 1: Bypassed 2: Not recommended. Use OSC_2X instead of MULT 3: 3X 7: 7X 8 - 31: Not recommended
6 - 0		R/W	78h	Program 78h to this field.

# 7.6.12 Register R11 (offset = 0Bh) [reset = B018h]

# Figure 49. Register R11

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	0	1	1		PLL_R 1 0 0 0								0		
	R/V	/-Bh			R/W-1h R/W-8h								/-8h		

# Table 19. Register R11 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 12		R/W	Bh	Program Bh to this field.
11 - 4	PLL_R	R/W	1h	Reference path Post-R divider. It is the divider after the frequency Multiplier.
3 - 0		R/W	8h	Program 8h to this field.



# 7.6.13 Register R12 (offset = 0Ch) [reset = 5001h]

## Figure 50. Register R12

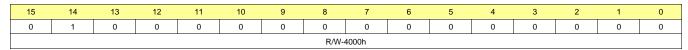
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	1						PLL_R	_PRE					
	R/V	V-5h							R/M	/-1h					

# Table 20. Register R12 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 12		R/W	5h	Program 5h to this field.
11 - 0	PLL_R_PRE	R/W	1h	Reference path Pre-R divider. It is the divider before the frequency Multiplier.

# 7.6.14 Register R13 (offset = 0Dh) [reset = 4000h]

#### Figure 51. Register R13



# Table 21. Register R13 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	4000h	Program 4000h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.15 Register R14 (offset = 0Eh) [reset = 1840h]

#### Figure 52. Register R14

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	1	0	0	0	0		CF	PG		0	0	0
	R/W-30h									R/V	V-8h			R/W-0h	

# **Table 22. Register R14 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 7		R/W	30h	Program 30h to this field.
6 - 3	CPG	R/W	8h	Effective charge pump gain. This is the sum of the up and down currents. Each increment represents 625 $\mu$ A. 0: Tri-state 1: 625 $\mu$ A 2: 1250 $\mu$ A 3: 1875 $\mu$ A 15: 6875 $\mu$ A
2 - 0		R/W	0h	Program 0h to this field.

# 7.6.16 Register R15 (offset = 0Fh) [reset = 060Eh]

#### Figure 53. Register R15

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	0	0	0	0	0	1	1	1	0
	R/W-60Eh														

# Table 23. Register R15 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	60Eh	Program 60Eh to this field.
				After programming R0 with RESET = 1, no need to program this register.



# 7.6.17 Register R16 (offset = 10h) [reset = 0080h]

# Figure 54. Register R16

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0				V	CO_DACISE	T			
	R/W-0h										R/W-80h				

# Table 24. Register R16 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 9		R/W	0h	Program 0h to this field.
8 - 0	VCO_DACISET	R/W		Programmable current setting for the VCO that is applied when VCO_DACISET_FORCE = 1. Useful for fully-assisted VCO calibration.

# 7.6.18 Register R17 (offset = 11h) [reset = 0096h]

# Figure 55. Register R17

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0				VCO_	DACISET_S	STRT			
			R/W-0h								R/W-96h				

# Table 25. Register R17 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 9		R/W	0h	Program 0h to this field.
8 - 0	VCO_DACISET_STRT	R/W	96h	Starting calibration value for VCO_DACISET.

# 7.6.19 Register R18 (offset = 12h) [reset = 0064h]

# Figure 56. Register R18

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	1	1	0	0	1	0	0
							R/W	-64h							

# Table 26. Register R18 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	64h	Program 64h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.20 Register R19 (offset = 13h) [reset = 27B7h]

# Figure 57. Register R19

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	0	0	1	1	1				VCO_C	APCTRL			
			R/W	'-27h							R/W	-B7h			

#### **Table 27. Register R19 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 8		R/W	27h	Program 27h to this field.
7 - 0	VCO_CAPCTRL	R/W	B7h	Programmable band within VCO core that applies when VCO_CAPCTRL_FORCE = 1. Valid values are 183 to 0, where the higher number is a lower frequency.



# 7.6.21 Register R20 (offset = 14h) [reset = 3048h]

# Figure 58. Register R20

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1		VCO_SEL		VCO_SE L_FORC E	0	0	0	1	0	0	1	0	0	0
R/W	/-0h		R/W-6h		R/W-0h					R/W	-48h				

# **Table 28. Register R20 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 14		R/W	0h	Program 1h to this field.
13 - 11	VCO_SEL	R/W	6h	User specified start VCO for calibration. This sets the VCO that is used when VCO_SEL_FORCE = 1. 1: VCO1 2: VCO2 6: VCO6 All other values are not used.
10	VCO_SEL_FORCE	R/W	0h	Forces the VCO to use the core specified by VCO_SEL. 0: Disabled 1: Enabled
9 - 0		R/W	48h	Program 48h to this field.

# 7.6.22 Register R21 (offset = 15h) [reset = 0409h]

# Figure 59. Register R21

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	0	0	0	0	1	0	0	1
							R/W-	-409h							

# Table 29. Register R21 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	409h	Program 409h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.23 Register R22 (offset = 16h) [reset = 0001h]

# Figure 60. Register R22

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	1
							R/V	V-1h							

# Table 30. Register R22 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	1h	Program 1h to this field.  After programming R0 with RESET = 1, no need to program this register.



# 7.6.24 Register R23 (offset = 17h) [reset = 007Ch]

# Figure 61. Register R23

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	1	1	1	1	1	0	0
	R/W-7Ch														

# Table 31. Register R23 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	7Ch	Program 7Ch to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.25 Register R24 (offset = 18h) [reset = 071Ah]

# Figure 62. Register R24

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	1	0	0	0	1	1	0	1	0
	R/W-71Ah														

# Table 32. Register R24 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	71Ah	Program 71Ah to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.26 Register R25 (offset = 19h) [reset = 0624h]

# Figure 63. Register R25

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	0	0	0	1	0	0	1	0	0
	R/W-624h														

#### Table 33. Register R25 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	624h	Program 624h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.27 Register R26 (offset = 1Ah) [reset = 0808h]

# Figure 64. Register R26

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1	0	0	0	0	0	0	0	1	0	0	0
	R/W-808h														

#### Table 34. Register R26 Field Descriptions

Bit	Field	Туре	Reset	Description
15 -	)	R/W	808h	Program 808h to this field.
				After programming R0 with RESET = 1, no need to program this register.



### 7.6.28 Register R27 (offset = 1Bh) [reset = 0002h]

#### Figure 65. Register R27

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	1	0
							R/V	/-2h							

### Table 35. Register R27 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	2h	Program 2h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.29 Register R28 (offset = 1Ch) [reset = 0488h]

### Figure 66. Register R28

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	1	0	0	0	1	0	0	0
		•	•				R/W-	488h					•		

### Table 36. Register R28 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	488h	Program 488h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.30 Register R29 (offset = 1Dh) [reset = 18C6h]

### Figure 67. Register R29

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/W-	18C6h							

#### Table 37. Register R29 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	18C6h	Program 0h to this field.

### 7.6.31 Register R30 (offset = 1Eh) [reset = 18C6h]

### Figure 68. Register R30

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	1	0	0	0	1	0	1	0	0	1	1	0
							R/W-	18C6h							

# Table 38. Register R30 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	18C6h	Program 18A6h to this field.



#### 7.6.32 Register R31 (offset = 1Fh) [reset = C3E6h]

#### Figure 69. Register R31

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	0	0	0	1	1	1	1	1	0	0	1	1	0
	•						R/W-0	C3E6h							

### Table 39. Register R31 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	C3E6h	Program C3E6h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.33 Register R32 (offset = 20h) [reset = 05BFh]

### Figure 70. Register R32

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	1	1	0	1	1	1	1	1	1
							R/W-	5BFh							

### Table 40. Register R32 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	5BFh	Program 5BFh to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.34 Register R33 (offset = 21h) [reset = 1E01h]

### Figure 71. Register R33

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	1	1	1	0	0	0	0	0	0	0	0	1
	R/W-1E01h														

#### Table 41. Register R33 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	1E01h	Program 1E01h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.35 Register R34 (offset = 22h) [reset = 0010h]

### Figure 72. Register R34

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	1	0	PLL_N[18:16]		
RW-2h												R/W-0h			

#### Table 42. Register R34 Field Descriptions

Bit	Field	Type	Reset	Description
15 - 3		R/W	2h	Program 2h to this field.
2 - 0	PLL_N[18:16]	R/W	0h	Upper 3 bits of N-divider.



### 7.6.36 Register R35 (offset = 23h) [reset = 0004h]

#### Figure 73. Register R35

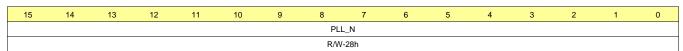
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	1	0	0
	R/W-4h														

### Table 43. Register R35 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	4h	Program 4h to this field.
				After programming R0 with RESET = 1, no need to program this register.

#### 7.6.37 Register R36 (offset = 24h) [reset = 0028h]

### Figure 74. Register R36



### Table 44. Register R36 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	PLL_N	R/W	28h	Lower 16 bits of N-divider.

### 7.6.38 Register R37 (offset = 25h) [reset = 0205h]

### Figure 75. Register R37

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
MASH_S EED_EN	0		PFD_DLY_SEL						0	0	0	0	1	0	1
R/W-0h	R/W-0h			R/W	/-2h						R/V	V-5h			

#### **Table 45. Register R37 Field Descriptions**

Bit	Field	Туре	Reset	Description
15	MASH_SEED_EN	R/W	0h	Enables the MASH_SEED value to be used. This can be used for programmable phase stepping or fractional spur optimization.  0: Disabled  1: Enabled
14		R/W	0h	Program 0h to this field.
13 - 8	PFD_DLY_SEL	R/W	2h	PFD_DLY_SEL must be adjusted in accordance to the N-divider value. See Table 3 for details.
7 - 0		R/W	5h	Program 5h to this field.

### 7.6.39 Register R38 (offset = 26h) [reset = FFFFh]

# Figure 76. Register R38

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_DEN[31:16]															
	R/W-FFFFh														

### Table 46. Register R38 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	PLL_DEN[31:16]	R/W	FFFFh	Upper 16 bits of fractional denominator (DEN).



### 7.6.40 Register R39 (offset = 27h) [reset = FFFFh]

#### Figure 77. Register R39

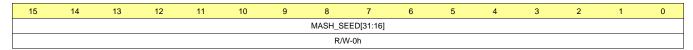
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
PLL_DEN[15:0]															
							R/W-	FFFFh							

### Table 47. Register R39 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	PLL_DEN[15:0]	R/W	FFFFh	Lower 16 bits of fractional denominator (DEN).

### 7.6.41 Register R40 (offset = 28h) [reset = 0000h]

#### Figure 78. Register R40



### Table 48. Register R40 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	MASH_SEED[31:16]	R/W	0h	Upper 16 bits of MASH_SEED. MASH_SEED sets the initial state of the fractional
				engine. Useful for producing a phase shift and fractional spur optimization.

### 7.6.42 Register R41 (offset = 29h) [reset = 0000h]

### Figure 79. Register R41

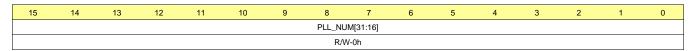


# Table 49. Register R41 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	MASH_SEED[15:0]	R/W	-	Lower 16 bits of MASH_SEED. MASH_SEED sets the initial state of the fractional engine. Useful for producing a phase shift and fractional spur optimization.

### 7.6.43 Register R42 (offset = 2Ah) [reset = 0000h]

#### Figure 80. Register R42



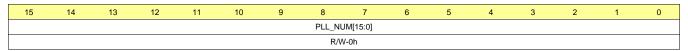
### Table 50. Register R42 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	PLL_NUM[31:16]	R/W	0h	Upper 16 bits of fractional numerator (NUM).



# 7.6.44 Register R43 (offset = 2Bh) [reset = 0000h]

### Figure 81. Register R43



### Table 51. Register R43 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	PLL_NUM[15:0]	R/W	0h	Lower 16 bits of fractional numerator (NUM).

# 7.6.45 Register R44 (offset = 2Ch) [reset = 22A2h]

# Figure 82. Register R44

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	OUTA_PWR							OUTA_P D	MASH_R ESET_N	0	0	N	ASH_ORDER	3
R/V	R/W-0h R/W-22h					R/W-1h	R/W-0h	R/W-1h	R/V	V-0h		R/W-2h			

## Table 52. Register R44 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 14		R/W	0h	Program 0h to this field.
13 - 8	OUTA_PWR	R/W	22h	Adjusts RFoutA output power. Higher numbers give more output power.
7	OUTB_PD	R/W	1h	Powers down RF output B. 0: Normal operation 1: Power down
6	OUTA_PD	R/W	0h	Powers down RF output A. 0: Normal operation 1: Power down
5	MASH_RESET_N	R/W	1h	Resets MASH. 0: Reset 1: Normal operation
4 - 3		R/W	0h	Program 0h to this field.
2 - 0	MASH_ORDER	R/W	2h	Sets the MASH order. 0: Integer mode 1: First order modulator 2: Second order modulator 3: Third order modulator 4: Fourth order modulator 5 - 7: Not used



### 7.6.46 Register R45 (offset = 2Dh) [reset = C622h]

### Figure 83. Register R45

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
1	1	0	OUTA	_MUX	1 1 0 0 0					OUTB_PWR					
	R/W-6h		R/W	/-0h			R/W-18h			R/W-22h					

### Table 53. Register R45 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 13		R/W	6h	Program 6h to this field.
12 - 11	OUTA_MUX	R/W	0h	Selects the input source to RFoutA. 0: Channel divider 1: VCO 2: Not used 3: High impedance
10 - 6		R/W	18h	Program 18h to this field.
5 - 0	OUTB_PWR	R/W	22h	Adjusts RFoutB output power. Higher numbers give more output power.

# 7.6.47 Register R46 (offset = 2Eh) [reset = 07F0h]

### Figure 84. Register R46

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	1	1	1	1	1	1	0	0	OUTB_MUX	
	R/W-1FCh												R/W-	-0h	

#### Table 54. Register R46 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 2		R/W	1FCh	Program 1FCh to this field.
1 - 0	OUTB_MUX	R/W	0h	Selects the input source to RFoutB. 0: Channel divider 1: VCO 2: SYSREF 3: High impedance

### 7.6.48 Register R47 (offset = 2Fh) [reset = 0300h]

# Figure 85. Register R47

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	0	0	0	0	0	0	0	0
	R/W-300h														

# Table 55. Register R47 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	300h	Program 300h to this field.
				After programming R0 with RESET = 1, no need to program this register.



### 7.6.49 Register R48 (offset = 30h) [reset = 03E0h]

#### Figure 86. Register R48

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	1	1	1	0	0	0	0	0
							R/W-	3E0h							

### Table 56. Register R48 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	3E0h	Program 3E0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.50 Register R49 (offset = 31h) [reset = 4180h]

### Figure 87. Register R49

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	0	0	0	0	0	1	1	0	0	0	0	0	0	0
				•			R/W-	1180h					•		

### Table 57. Register R49 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	4180h	Program 4180h to this field.
				After programming R0 with RESET = 1, no need to program this register.

#### 7.6.51 Register R50 (offset = 32h) [reset = 0080h]

### Figure 88. Register R50

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
							R/W	-80h							

#### Table 58. Register R50 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	80h	Program 80h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.52 Register R51 (offset = 33h) [reset = 0080h]

### Figure 89. Register R51

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	0	0	0	0	0	0
							R/W	′-80h							

#### Table 59. Register R51 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	80h	Program 80h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.53 Register R52 (offset = 34h) [reset = 0420h]

### Figure 90. Register R52

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	1	0	0	0	0	1	0	0	0	0	1
							R/W-	420h							



#### Table 60. Register R52 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	420h	Program 421h to this field.

#### 7.6.54 Register R53 (offset = 35h) [reset = 0000h]

### Figure 91. Register R53

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	/-0h							

### Table 61. Register R53 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.55 Register R54 (offset = 36h) [reset = 0000h]

#### Figure 92. Register R54

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	/-0h							

### Table 62. Register R54 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.56 Register R55 (offset = 37h) [reset = 0000h]

### Figure 93. Register R55

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	/-0h							

#### Table 63. Register R55 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.57 Register R56 (offset = 38h) [reset = 0000h]

### Figure 94. Register R56

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	/-0h							

### Table 64. Register R56 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.



### 7.6.58 Register R57 (offset = 39h) [reset = 0000h]

### Figure 95. Register R57

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	1	0	0	0	0	0
				•	•		R/V	/-0h		•					

### Table 65. Register R57 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 20h to this field.

### 7.6.59 Register R58 (offset = 3Ah) [reset = 8001h]

# Figure 96. Register R58

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
INPIN_I GNORE	INPIN_H YST	INPIN	_LVL		INPIN_FMT		0	0	0	0	0	0	0	0	1
R/W-1h	R/W-0h	R/W	'-0h		R/W-0h						R/W-1h				

### Table 66. Register R58 Field Descriptions

Bit	Field	Туре	Reset	Description
15	INPIN_IGNORE	R/W	1h	Ignore SYNC and SysRefReq pins when VCO_PHASE_SYNC = 0. This bit should be set to 1 unless VCO_PHASE_SYNC = 1.
14	INPIN_HYST	R/W	0h	Enables high hysteresis for LVDS input to SysRefReq and SYNC pin. 0: Disabled 1: Enabled
13 - 12	INPIN_LVL	R/W	0h	Sets bias level for LVDS input to SysRefReq and SYNC pin. 0: Vin / 4 1: Vin 2: Vin / 2 3: Invalid
11 - 9	INPIN_FMT	R/W	Oh	Defines the input format of SysRefReq and SYNC pin.  0: SYNC = SysRefReq = CMOS  1: SYNC = LVDS; SysRefReq = CMOS  2: SYNC = CMOS; SysRefReq = LVDS  3: SYNC = SysRefReq = LVDS  4: SYNC = SysRefReq = CMOS  5: SYNC = LVDS (filtered); SysRefReq = CMOS  6: SYNC = CMOS; SysRefReq = LVDS (filtered)  7: SYNC = SysRefReq = LVDS (filtered)
8 - 0		R/W	1h	Program 1h to this field.

### 7.6.60 Register R59 (offset = 3Bh) [reset = 0001h]

### Figure 97. Register R59

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	LD_TYP E
							R/W-0h								R/W-1h

#### Table 67. Register R59 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 1		R/W	0h	Program 0h to this field.
0	LD_TYPE	R/W	1h	Defines lock detect type.  0: VCOCal. Lock detect asserts a HIGH output after the VCO has finished calibration and the LD_DLY timeout counter is finished.  1: Vtune and VCOCal. Lock detect asserts a HIGH output when VCOCal lock detect would assert a HIGH signal and the tuning voltage to the VCO is within acceptable limits.



### 7.6.61 Register R60 (offset = 3Ch) [reset = 03E8h]

### Figure 98. Register R60

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
LD_DLY															
							R/W-	-3E8h							

### Table 68. Register R60 Field Descriptions

Ī	Bit	Field	Туре	Reset	Description
	15 - 0	LD_DLY	R/W		For the VCOCal lock detect, this is the delay in ¼ f <sub>PD</sub> cycles that is added after the calibration is finished before the VCOCal lock detect is asserted HIGH.

### 7.6.62 Register R61 (offset = 3Dh) [reset = 00A8h]

### Figure 99. Register R61

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	1	0	1	0	1	0	0	0
							R/W	-A8h							

### Table 69. Register R61 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	A8h	Program A8h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.63 Register R62 (offset = 3Eh) [reset = 00AFh]

# Figure 100. Register R62

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
DBLBUF _EN_5	DBLBUF _EN_4	DBLBUF _EN_3	DBLBUF _EN_2	DBLBUF _EN_1	DBLBUF _EN_0	0	0	1	0	1	0	1	1	1	1
R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h	R/W-0h					R/W	-AFh				

### Table 70. Register R62 Field Descriptions

Bit	Field	Туре	Reset	Description
15	DBLBUF_EN_5	R/W	0h	Enables double buffering for the MASH order. 0: Disabled 1: Enabled
14	DBLBUF_EN_4	R/W	0h	Enables double buffering for fractional numerator NUM. 0: Disabled 1: Enabled
13	DBLBUF_EN_3	R/W	0h	Enables double buffering for the integer portion of the N-divider. 0: Disabled 1: Enabled
12	DBLBUF_EN_2	R/W	0h	Enables double buffering for the Pre-R and Post-R dividers in the reference path.  Effective only if DBL_BUF_EN_3 = 1.  0: Disabled  1: Enabled
11	DBLBUF_EN_1	R/W	0h	Enables double buffering for the Multiplier in the reference path. Effective only if DBL_BUF_EN_3 = 1.  0: Disabled 1: Enabled
10	DBLBUF_EN_0	R/W	0h	Enables double buffering for the Doubler in the reference path. Effective only if DBL_BUF_EN_3 = 1.  0: Disabled 1: Enabled
9 - 0		R/W	AFh	Program AFh to this field.



### 7.6.64 Register R63 (offset = 3Fh) [reset = 0000h]

#### Figure 101. Register R63

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	•						R/V	V-0h							

### Table 71. Register R63 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

#### 7.6.65 Register R64 (offset = 40h) [reset = 1388h]

### Figure 102. Register R64

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	1	0	0	1	1	1	0	0	0	1	0	0	0
	R/W-1388h														

### Table 72. Register R64 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	1388h	Program 1388h to this field.
				After programming R0 with RESET = 1, no need to program this register.

#### 7.6.66 Register R65 (offset = 41h) [reset = 0000h]

### Figure 103. Register R65

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/M	/-0h							

#### Table 73. Register R65 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.67 Register R66 (offset = 42h) [reset = 01F4h]

### Figure 104. Register R66

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	1	1	1	1	1	0	1	0	0
							R/W-	·1F4h							

#### Table 74. Register R66 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	1F4h	Program 1F4h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.68 Register R67 (offset = 43h) [reset = 0000h]

### Figure 105. Register R67

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	V-0h							



### Table 75. Register R67 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.69 Register R68 (offset = 44h) [reset = 03E8h]

# Figure 106. Register R68

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	1	1	1	1	1	0	1	0	0	0
							R/W-	3E8h							

#### Table 76. Register R68 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	3E8h	Program 3E8h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.70 Register R69 (offset = 45h) [reset = 0000h]

# Figure 107. Register R69

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	MASH_RST_COUNT[31:16]														
							R/W	/-0h							

### Table 77. Register R69 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	MASH_RST_COUNT [31:16]	R/W		Upper 16 bits of MASH_RST_COUNT. This register is used to add a delay when using phase SYNC. The delay should be set at least four times the PLL lock time. This delay is expressed in state machine clock periods. One of these periods is equal to $2^{\text{CAL\_CLK\_DIV}} / f_{\text{OSCin}}$ .

### 7.6.71 Register R70 (offset = 46h) [reset = C350h]

# Figure 108. Register R70

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						N	MASH_RST_	COUNT[15:	0]						
							R/W-	C350h							

### Table 78. Register R70 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	MASH_RST_COUNT [15:0]	R/W	C350h	Lower 16 bits of MASH_RST_COUNT.

### 7.6.72 Register R71 (offset = 47h) [reset = 0080h]

### Figure 109. Register R71

1	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	0	SYS	REF_DIV_	PRE	SYSREF _PULSE	SYSREF _EN	SYSREF _REPEA T	0	1
	R/W-0h									R/W-4h		R/W-0h	R/W-0h	R/W-0h	R/V	V-0h



### Table 79. Register R71 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 8		R/W	0h	Program 0h to this field.
7 - 5	SYSREF_DIV_PRE	R/W	4h	This divider is used to get the frequency input to the Post-SR divider within acceptable limits. See Application for SYSREF for details.  2: Divide by 2  4: Divide by 4  All other values are invalid.
4	SYSREF_PULSE	R/W	Oh	When in master mode (SYSREF_REPEAT = 0), this allows multiple pulses (as determined by SYSREF_PULSE_CNT) to be sent out whenever the SysRefReq pin goes high.  0: Disabled  1: Enabled
3	SYSREF_EN	R/W	0h	Enables SYSREF mode. 0: Disabled 1: Enabled
2	SYSREF_REPEAT	R/W	0h	Defines SYSREF mode. 0: Master mode. In this mode, SYSREF pulses are generated continuously at the output. 1: Repeater Mode. In this mode, SYSREF pulses are generated in response to the SysRefReq pin.
1 - 0		R/W	0h	Program 1h to this field.

### 7.6.73 Register R72 (offset = 48h) [reset = 0001h]

### Figure 110. Register R72

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0					5	SYSREF_DI	V				
	•	R/W-0h								R/W-1h					

### Table 80. Register R72 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 11		R/W	0h	Program 0h to this field.
10 - 0	SYSREF_DIV	R/W	1h	This divider further divides the output frequency for the SYSREF. See Application for SYSREF for details.

# 7.6.74 Register R73 (offset = 49h) [reset = 003Fh]

### Figure 111. Register R73

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0			JESD_DA	C2_CTRL					JESD_DA	C1_CTRL		
	R/V	V-0h				R/V	/-0h					R/W	-3Fh		

### **Table 81. Register R73 Field Descriptions**

Bit	Field	Туре	Reset	Description
15 - 12		R/W	0h	Program 0h to this field.
11 - 6	JESD_DAC2_CTRL	R/W	0h	Programmable delay adjustment for SYSREF mode.
5 - 0	JESD_DAC1_CTRL	R/W	3Fh	Programmable delay adjustment for SYSREF mode.

# 7.6.75 Register R74 (offset = 4Ah) [reset = 0000h]

# Figure 112. Register R74

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0		
	SYSREF_F	PULSE_CNT		JESD_DAC4_CTRL							JESD_DAC3_CTRL						
	R/V	V-0h				R/V	V-0h					R/V	V-0h				



### Table 82. Register R74 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 12	SYSREF_PULSE_CNT	R/W	0h	Used in SYSREF_REPEAT mode to define how many pulses are sent.
11 - 6	JESD_DAC4_CTRL	R/W	0h	Programmable delay adjustment for SYSREF mode.
5 - 0	JESD_DAC3_CTRL	R/W	0h	Programmable delay adjustment for SYSREF mode.

# 7.6.76 Register R75 (offset = 4Bh) [reset = 0800h]

# Figure 113. Register R75

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	1			CHDIV			0	0	0	0	0	0
		R/W-1h	•				R/W-0h					R/V	V-0h	•	

#### Table 83. Register R75 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 11		R/W	1h	Program 1h to this field.
10 - 6	CHDIV	R/W	Oh	Channel divider. 0: Divide by 2 1: Divide by 4 3: Divide by 8 5: Divide by 16 7: Divide by 32 9: Divide by 64 12: Divide by 128 14: Divide by 256 All other values are not used.
5 - 0		R/W	0h	Program 0h to this field.

### 7.6.77 Register R76 (offset = 4Ch) [reset = 000Ch]

### Figure 114. Register R76

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	1	1	0	0
							R/W	/-Ch							

### Table 84. Register R76 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	Ch	Program Ch to this field.
				After programming R0 with RESET = 1, no need to program this register.

# 7.6.78 Register R77 (offset = 4Dh) [reset = 0000h]

# Figure 115. Register R77

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	V-0h	•						

### Table 85. Register R77 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.



### 7.6.79 Register R78 (offset = 4Eh) [reset = 0064h]

#### Figure 116. Register R78

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	RAMP_T HRESH[ 32]		QUICK_ RECAL_ EN				VCO_CAPO	TRL_STRT				1
	R/V	/-0h		R/W-0h	R/W-0h	R/W-0h				R/W	-32h				R/W-0h

### Table 86. Register R78 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 12	T TOTAL	R/W	0h	Program 0h to this field.
11	RAMP_THRESH[32]	R/W	0h	The $33^{rd}$ bit of RAMP_THRESH. RAMP_THRESH sets how much the ramp can change the VCO frequency before a VCO calibration is required. If the frequency is chosen to be $\Delta f$ , then RAMP_THRESH = $(\Delta f / f_{PD}) \times 2^{24}$ .
10		R/W	0h	Program 0h to this field.
9	QUICK_RECAL_EN	R/W	0h	This sets the initial VCO starting calibration values. Especially useful if the frequency change is smaller, say < 50 MHz or so.  0: Calibration starts with VCO_SEL, VCO_CAPCTRL_START, VCO_DACISET_START  1: Calibration starts with the current value
8 - 1	VCO_CAPCTRL_STRT	R/W	32h	This sets the starting VCO_CAPCTRL value that is used for VCO frequency calibration. Smaller values yield a higher frequency band within a VCO core. Valid number range is 0 to 183.
0		R/W	0h	Program 1h to this field.

### 7.6.80 Register R79 (offset = 4Fh) [reset = 0000h]

### Figure 117. Register R79

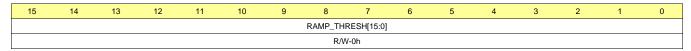
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							RAMP_THE	RESH[31:16]							
							R/W	/-0h							

### Table 87. Register R79 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP_THRESH[31:16]	R/W	0h	Upper 16 bits of RAMP_THRESH. See Table 86 for description.

# 7.6.81 Register R80 (offset = 50h) [reset = 0000h]

# Figure 118. Register R80



### Table 88. Register R80 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP_THRESH[15:0]	R/W	0h	Lower 16 bits of RAMP_THRESH. See Table 86 for description.

### 7.6.82 Register R81 (offset = 51h) [reset = 0000h]

# Figure 119. Register R81

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	RAMP_L IMIT_HI GH[32]
R/W-0h R/											R/W-0h				

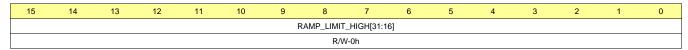


### Table 89. Register R81 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 1		R/W	0h	Program 0h to this field.
0	RAMP_LIMIT_HIGH[32]	R/W		The $33^{rd}$ bit of RAMP_LIMIT_HIGH. RAMP_LIMIT_HIGH sets a maximum frequency that the ramp cannot exceed so that the VCO does not get set beyond a valid frequency range. Suppose $f_{HIGH}$ is this frequency and $f_{VCO}$ is the starting VCO frequency, then: $f_{HIGH} \ge f_{VCO}$ ; RAMP_LIMIT_HIGH = $2^{24} \times (f_{HIGH} - f_{VCO}) / f_{PD}$

# 7.6.83 Register R82 (offset = 52h) [reset = 0000h]

### Figure 120. Register R82

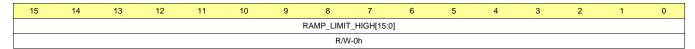


### Table 90. Register R82 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP_LIMIT_HIGH [31:16]	R/W	0h	Upper 16 bits of RAMP_LIMIT_HIGH. See Table 89 for description.

# 7.6.84 Register R83 (offset = 53h) [reset = 0000h]

### Figure 121. Register R83



#### Table 91. Register R83 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP_LIMIT_HIGH[15:0]	R/W	0h	Lower 16 bits of RAMP_LIMIT_HIGH. See Table 89 for description.

### 7.6.85 Register R84 (offset = 54h) [reset = 0000h]

### Figure 122. Register R84

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	RAMP_L IMIT_LO W[32]
R/W-0h										R/W-0h					

### Table 92. Register R84 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 1		R/W	0h	Program 0h to this field.
0	RAMP_LIMIT_LOW[32]	R/W	Oh	The $33^{rd}$ bit of RAMP_LIMIT_LOW. RAMP_LIMIT_LOW sets a minimum frequency that the ramp cannot exceed so that the VCO does not get set beyond a valid frequency range. Suppose $f_{LOW}$ is this frequency and $f_{VCO}$ is the starting VCO frequency, then: $f_{LOW} \le f_{VCO}$ ; RAMP_LIMIT_LOW = $2^{33} - 2^{24} \times (f_{VCO} - f_{LOW}) / f_{PD}$



### 7.6.86 Register R85 (offset = 55h) [reset = 0000h]

#### Figure 123. Register R85

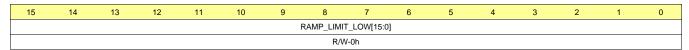
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	RAMP_LIMIT_LOW[31:16]														
							R/V	V-0h							

### Table 93. Register R85 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP_LIMIT_LOW [31:16]	R/W	0h	Upper 16 bits of RAMP_LIMIT_LOW. See Table 92 for description.

### 7.6.87 Register R86 (offset = 56h) [reset = 0000h]

#### Figure 124. Register R86



# Table 94. Register R86 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP_LIMIT_LOW[15:0]	R/W	0h	Lower 16 bits of RAMP_LIMIT_LOW. See Table 92 for description.

### 7.6.88 Register R87 (offset = 57h) [reset = 0000h]

### Figure 125. Register R87

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	R/W-0h														

### Table 95. Register R87 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.89 Register R88 (offset = 58h) [reset = 0000h]

#### Figure 126. Register R88

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

#### Table 96. Register R88 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.90 Register R89 (offset = 59h) [reset = 0000h]

## Figure 127. Register R89

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	/-0h							



### Table 97. Register R89 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.91 Register R90 (offset = 5Ah) [reset = 0000h]

### Figure 128. Register R90

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	V-0h							

### Table 98. Register R90 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.92 Register R91 (offset = 5Bh) [reset = 0000h]

# Figure 129. Register R91

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R/W-0h															

#### Table 99. Register R91 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W		Program 0h to this field.  After programming R0 with RESET = 1, no need to program this register.

### 7.6.93 Register R92 (offset = 5Ch) [reset = 0000h]

#### Figure 130. Register R92

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R/V	V-Oh							

### Table 100. Register R92 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.94 Register R93 (offset = 5Dh) [reset = 0000h]

# Figure 131. Register R93

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	R/W-0h														

### Table 101. Register R93 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.



### 7.6.95 Register R94 (offset = 5Eh) [reset = 0000h]

#### Figure 132. Register R94

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	R/W-0h														

### Table 102. Register R94 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

#### 7.6.96 Register R95 (offset = 5Fh) [reset = 0000h]

### Figure 133. Register R95

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
	R/W-0h														

### Table 103. Register R95 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R/W	0h	Program 0h to this field.
				After programming R0 with RESET = 1, no need to program this register.

### 7.6.97 Register R96 (offset = 60h) [reset = 0000h]

### Figure 134. Register R96

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_B URST_E N						RAMP	_BURST_C	COUNT						0	0
R/W-0h							R/W-0h							R/W	/-0h

### Table 104. Register R96 Field Descriptions

Bit	Field	Туре	Reset	Description
15	RAMP_BURST_EN	R/W		This enables ramp burst mode. In this mode, a number of ramps equal to RAMP_BURST_COUNT is sent out whenever RAMP_EN is set to 1. This is intended to produce a finite pattern of ramps, instead of a continuous pattern.  0: Disabled  1: Enabled
14 - 2	RAMP_BURST_COUNT	R/W	0h	When RAMP_BURST_EN = 1, this sets the number of ramps that is sent out.
1 - 0		R/W	0h	Program 0h to this field.

# 7.6.98 Register R97 (offset = 61h) [reset = 0000h]

### Figure 135. Register R97

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP0_ RST	0	0	0	0		RAMP_	TRIGB			RAMP_	TRIGA		0	RAMP_BL	2
R/W-0h		R/V	V-0h			R/W	/-0h			R/W	/-0h		R/W-0h	R/M	/-0h



# Table 105. Register R97 Field Descriptions

Bit	Field	Туре	Reset	Description
15	RAMP0_RST	R/W	0h	Resets RAMP0 at start of ramp to eliminate round-off errors. Applies to automatic ramping mode only. 0: Disabled 1: Reset
14 - 11		R/W	0h	Program 0h to this field.
10 - 7	RAMP_TRIGB	R/W	Oh	Definition of ramp trigger B. 0: Disabled 1: RampClk pin rising edge 2: RampDir pin rising edge 4: Always triggered 9: RampClk pin falling edge 10: RampDir pin falling edge All other values are not used.
6 - 3	RAMP_TRIGA	R/W	0h	Definition of ramp trigger A. Options are same as RAMP_TRIGB.
2		R/W	0h	Program 0h to this field.
1 - 0	RAMP_BURST_TRIG	R/W	0h	Sets what triggers the next ramp in burst mode. 0: Ramp transition 1: Trigger A 2: Trigger B 3: Not used

# 7.6.99 Register R98 (offset = 62h) [reset = 0000h]

# Figure 136. Register R98

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
						RAMP0_I	NC[29:16]							0	RAMP0_ DLY
						R/W	/-0h							R/W-0h	R/W-0h

# Table 106. Register R98 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 2	RAMP0_INC[29:16]	R/W	0h	Upper 14 bits of RAMP0_INC. RAMP0_INC sets the 2's compliment of the number added to the fractional numerator on every ramp cycle.
1		R/W	0h	Program 0h to this field.
0	RAMP0_DLY	R/W	0h	When enabled, increases RAMP0 length by basing the ramp clock on two phase detector cycles instead of one.  0: Ramp clock = 1 f <sub>PD</sub> cycle  1: Ramp clock = 2 f <sub>PD</sub> cycles

# 7.6.100 Register R99 (offset = 63h) [reset = 0000h]

### Figure 137. Register R99

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							RAMP0_	INC[15:0]							
							R/W	/-0h							

# Table 107. Register R99 Field Descriptions

Bi	t Field	Туре	Reset	Description
15 -	0 RAMP0_INC[15:0]	R/W	0h	Lower 16 bits of RAMP0_INC. See Table 106 for description.



# 7.6.101 Register R100 (offset = 64h) [reset = 0000h]

### Figure 138. Register R100

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							RAMP	0_LEN							
							R/V	/-0h							

### Table 108. Register R100 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP0_LEN	R/W	0h	Length of the ramp in phase detector cycles.

### 7.6.102 Register R101 (offset = 65h) [reset = 0000h]

# Figure 139. Register R101

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1 0
0	0	0	0	0	0	0	0	0	RAMP1_ DLY	RAMP1_ RST	RAMP0_ NEXT	0	0	RAMP0_NEXT_TF
				R/W-0h					R/W-0h	R/W-0h	R/W-0h	R/V	V-0h	R/W-0h

### Table 109. Register R101 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 7		R/W	0h	Program 0h to this field.
6	RAMP1_DLY	R/W	0h	When enabled, increases RAMP1 length by basing the ramp clock on two phase detector cycles instead of one.  0: Ramp clock = 1 f <sub>PD</sub> cycle  1: Ramp clock = 2 f <sub>PD</sub> cycles
5	RAMP1_RST	R/W	0h	Resets RAMP1 at start of ramp to eliminate round-off errors. Applies to automatic ramping mode only.  0: Disabled 1: Reset
4	RAMP0_NEXT	R/W	0h	Defines what ramp comes after RAMP0. 0: RAMP0 1: RAMP1
3 - 2		R/W	0h	Program 0h to this field.
1 - 0	RAMP0_NEXT_TRIG	R/W	Oh	Defines what triggers the next ramp. 0: RAMPO_LEN timeout counter 1: Trigger A 2: Trigger B 3: Not used

### 7.6.103 Register R102 (offset = 66h) [reset = 0000h]

# Figure 140. Register R102

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0							RAMP1_I	NC[29:16]						
R/W	/-0h							R/W	/-0h						

# Table 110. Register R102 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 14		R/W	0h	Program 0h to this field.
13 - 0	RAMP1_INC[29:16]	R/W	0h	Upper 14 bits of RAMP1_INC. RAMP1_INC sets the 2's compliment of the number added to the fractional numerator on every ramp cycle.



### 7.6.104 Register R103 (offset = 67h) [reset = 0000h]

## Figure 141. Register R103

15 14 13 12 11 10 9 8 7 6 5 4 3 2 1 0

RAMP1\_INC[15:0]

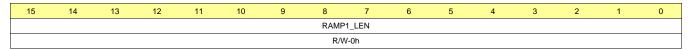
R/W-0h

### Table 111. Register R103 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP1_INC[15:0]	R/W	0h	Lower 16 bits of RAMP1_INC. See Table 110 for description.

#### 7.6.105 Register R104 (offset = 68h) [reset = 0000h]

### Figure 142. Register R104



### Table 112. Register R104 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	RAMP1_LEN	R/W	0h	Length of the ramp in phase detector cycles.

#### 7.6.106 Register R105 (offset = 69h) [reset = 4440h]

### Figure 143. Register R105

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
RAMP_DLY_CNT											RAMP1_ NEXT	0	0		NEXT_TRI G
	R/W-111h											R/V	V-0h	RΛ	W-0h

#### Table 113. Register R105 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 6	RAMP_DLY_CNT	R/W	111h	For ramping mode, RAMP_DLY_CNT and RAMP_SCALE_COUNT determine the minimum necessary time taken for VCO calibration during the ramp. Min. VCOCal time = (1 / $f_{smc}$ ) / (RAMP_DLY_CNT × $2^{RAMP\_SCALE\_COUNT}$ ), where $f_{smc} = f_{OSCin} / 2^{CAL\_CLK\_DIV}$ .
5	RAMP_MANUAL	R/W	0h	Selects the ramping mode. 0: Automatic ramping mode 1: Manual (Pin) ramping mode
4	RAMP1_NEXT	R/W	0h	Defines what ramp comes after RAMP1. 0: RAMP0 1: RAMP1
3 - 2		R/W	0h	Program 0h to this field.
1 - 0	RAMP1_NEXT_TRIG	R/W	Oh	Defines what triggers the next ramp. 0: RAMP1_LEN timeout counter 1: Trigger A 2: Trigger B 3: Not used

## 7.6.107 Register R106 (offset = 6Ah) [reset = 0007h]

### Figure 144. Register R106

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	RAMP_T RIG_CA L	0	RAMP_	SCALE_CO	TNUC
					R/W-0h						R/W-0h	R/W-0h		R/W-7h	



### Table 114. Register R106 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 5		R/W	0h	Program 0h to this field.
4	RAMP_TRIG_CAL	R/W	0h	Enabling this bit causes VCO calibration to occur in automatic ramping mode at the beginning of each ramp.  0: Disabled  1: Enabled
3		R/W	0h	Program 0h to this field.
2 - 0	RAMP_SCALE_COUNT	R/W	7h	For ramping mode, RAMP_DLY_CNT and RAMP_SCALE_COUNT determine the minimum necessary time taken for VCO calibration during the ramp. Min. VCOCal time = (1 / $f_{smc}$ ) / (RAMP_DLY_CNT × $2^{RAMP\_SCALE\_COUNT}$ ), where $f_{smc} = f_{OSCin} / 2^{CAL\_CLK\_DIV}$ .

#### 7.6.108 Register R107 (offset = 6Bh) [reset = 0000h]

## Figure 145. Register R107

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

# Table 115. Register R107 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

### 7.6.109 Register R108 (offset = 6Ch) [reset = 0000h]

### Figure 146. Register R108

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

### Table 116. Register R108 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

# 7.6.110 Register R109 (offset = 6Dh) [reset = 0000h]

#### Figure 147. Register R109

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
R-0h															

### Table 117. Register R109 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0		R	0h	Not used. (Read back only)

# 7.6.111 Register R110 (offset = 6Eh) [reset = 0000h]

### Figure 148. Register R110

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	rb_LD_V	/TUNE	0	r	b_VCO_SE	_	0	0	0	0	0
							R-	-0h							



### Table 118. Register R110 Field Descriptions

Bit	Field	Туре	Reset	Description
10 - 9	rb_LD_VTUNE	R	0h	Readback of Vtune lock detect. 0: Unlocked 1: Unlocked 2: Locked 3: Invalid
7 - 5	rb_VCO_SEL	R	Oh	Reads back the actual VCO that the calibration has selected. 1: VCO1 2: VCO2 6: VCO6 All other values are not used.

# 7.6.112 Register R111 (offset = 6Fh) [reset = 0000h]

### Figure 149. Register R111

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0				rb_VCO_0	CAPCTRL			
							R-	0h							

### Table 119. Register R111 Field Descriptions

Bit	Field	Туре	Reset	Description
7 - 0	rb_VCO_CAPCTRL	R	0h	Reads back the actual CAPCTRL value that the VCO calibration has chosen.

# 7.6.113 Register R112 (offset = 70h) [reset = 0000h]

### Figure 150. Register R112

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0				rb_	VCO_DACIS	SET			
							R-	0h							

### Table 120. Register R112 Field Descriptions

Bit	Field	Туре	Reset	Description
8 - 0	rb_VCO_DACISET	R	0h	Reads back the actual DACISET value that the VCO calibration has chosen.

# 7.6.114 Register R113 (offset = 71h) [reset = 0000h]

### Figure 151. Register R113

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0
							R-	0h							

### Table 121. Register R113 Field Descriptions

	Bit	Field	Type	Reset	Description
1	5 - 0		R	0h	Not used. (Read back only)

# 7.6.115 Register R114 (offset = 72h) [reset = 7800h]

# Figure 152. Register R114

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	1	1	1	1	FSK_EN		0		FSK_SP	I_LEVEL	FSK_	SPI_DEV_	SEL	FSK_MO	DE_SEL
		R/W-Fh			R/W-0h		R/W-0h		R/V	V-0h		R/W-0h		R/M	/-0h



### Table 122. Register R114 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 11		R/W	Fh	Program Fh to this field.
10	FSK_EN	R/W	0h	Enables all FSK modes. 0: Disabled 1: Enabled
9 - 7		R/W	0h	Program 0h to this field.
6 - 5	FSK_SPI_LEVEL	R/W	Oh	Defines the desired FSK level in FSK SPI mode. When this bit is zero, FSK operation in this mode is disabled even if FSK_EN = 1.  0: Disabled 1: 2FSK 2: 4FSK 3: 8FSK
4 - 2	FSK_SPI_DEV_SEL	R/W	Oh	In FSK SPI mode, these bits select one of the FSK deviations as defined in registers R116 - R123. 0: FSK_DEV0 1: FSK_DEV1 7: FSK_DEV7
1 - 0	FSK_MODE_SEL	R/W	0h	Defines FSK mode. 0: Not used 1: Not used 2: FSK SPI 3: FSK SPI FAST

# 7.6.116 Register R115 (offset = 73h) [reset = 0000h]

# Figure 153. Register R115

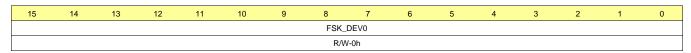
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0		FSI	K_DEV_SC	ALE		0	0	0
			R/V	V-0h						R/W-0h				R/W-0h	

### Table 123. Register R115 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 8		R/W	0h	Program 0h to this field.
7 - 3	FSK_DEV_SCALE	R/W	0h	The FSK deviation will be scaled by 2 <sup>FSK_DEV_SCALE</sup> .
2 - 0		R/W	0h	Program 0h to this field.

# 7.6.117 Register R116 (offset = 74h) [reset = 0000h]

### Figure 154. Register R116



# Table 124. Register R116 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV0	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

# 7.6.118 Register R117 (offset = 75h) [reset = 0000h]

## Figure 155. Register R117

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							FSK_	DEV1							
							R/W	/-0h							

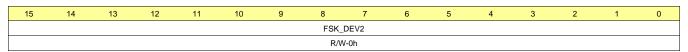


### Table 125. Register R117 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV1	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

#### 7.6.119 Register R118 (offset = 76h) [reset = 0000h]

### Figure 156. Register R118



### Table 126. Register R118 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV2	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

### 7.6.120 Register R119 (offset = 77h) [reset = 0000h]

#### Figure 157. Register R119

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							FSK_	DEV3							
							R/W	/-0h							

### Table 127. Register R119 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV3	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

# 7.6.121 Register R120 (offset = 78h) [reset = 0000h]

### Figure 158. Register R120

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							FSK_	DEV4							
							R/W	/-0h							

### Table 128. Register R120 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV4	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

### 7.6.122 Register R121 (offset = 79h) [reset = 0000h]

### Figure 159. Register R121

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							FSK_	DEV5							
							R/M	/-0h							

### Table 129. Register R121 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV5	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.



### 7.6.123 Register R122 (offset = 7Ah) [reset = 0000h]

#### Figure 160. Register R122

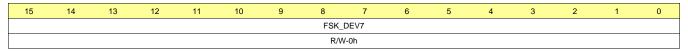
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
							FSK_	DEV6							
							R/W	/-0h							

### Table 130. Register R122 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV6	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

# 7.6.124 Register R123 (offset = 7Bh) [reset = 0000h]

# Figure 161. Register R123



### Table 131. Register R123 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_DEV7	R/W	0h	Defines the desired frequency deviation in FSK SPI mode.

#### 7.6.125 Register R124 (offset = 7Ch) [reset = 0000h]

### Figure 162. Register R124



### Table 132. Register R124 Field Descriptions

Bit	Field	Туре	Reset	Description
15 - 0	FSK_SPI_FAST_DEV	R/W	0h	Defines the desired frequency deviation in FSK SPI FAST mode.

### 7.6.126 Register R125 (offset = 7Dh) [reset = 2288h]

### Figure 163. Register R125

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	1	0	0	0	1	0	1	0	0	0	1	0	0	0
	R/W-2288h														

### Table 133. Register R125 Field Descriptions

E	Bit	Field	Туре	Reset	Description	
15	5 - 0		R/W	2288h	Program 2288h to this field.	
					After programming R0 with RESET = 1, no need to program this register.	



# 8 Application and Implementation

#### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 OSCin Configuration

OSCin supports single-ended and differential clock. Register R5 defines OSCin configuration.

**Table 134. OSCin Configuration** 

OSCin TYPE	SINGLE-ENDED CLOCK	DIFFERENTIAL CLOCK
Configuration Diagram	OSCin*	$\begin{array}{c c} & & & & & & \\ & & & & & \\ \hline & & & & & \\ \hline & & & &$
Register Setting	IPBUF_TYPE = 1	IPBUF_TYPE = 0 IPBUF_TERM = 1

Single-ended and differential input clock definitions are shown in Figure 164.

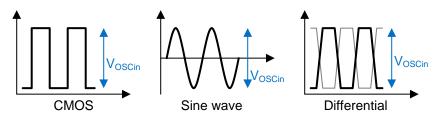


Figure 164. Input Clock Definition

#### 8.1.2 OSCin Slew Rate

The slew rate of the OSCin signal can have an impact on the spurs and phase noise of the LMX2572 if it is too low. In general, the best performance is for a high slew rate but a lower amplitude signal, such as LVDS.

### 8.1.3 VCO Gain

The VCO gain varies between the six VCO cores and is the lowest at the lowest end of the band and highest at the highest end of each band. The typical VCO gain over each VCO core is listed in Table 135.

Table 135. VCO Gain

VCO CORE	f <sub>Min</sub> (MHz)	f <sub>Max</sub> (MHz)	K <sub>VCO</sub> Min (MHz/V)	K <sub>VCO</sub> Max (MHz/V)
VCO1	3200	3650	32	47
VCO2	3650	4200	35	54
VCO3	4200	4650	47	64
VCO4	4650	5200	50	73
VCO5	5200	5750	61	82
VCO6	5750	6400	57	79



For an arbitrary VCO frequency, the VCO gain can be estimated as Equation 4:

$$K_{VCO} = K_{VCO}Min + (K_{VCO}Max - K_{VCO}Min) \times (f_{VCO} - f_{Min}) / (f_{Max} - f_{Min})$$
(4)

#### 8.1.4 VCO Calibration

The purpose of VCO calibration is to find out: (1) the correct VCO core, (2) the best band within the core, and (3) the best VCO amplitude setting. The LMX2572 allows the user to assist the VCO calibration. In general, there are three kinds of assistance.

#### 8.1.4.1 Partial Assist

Upon every frequency change, before the FCAL\_EN bit is checked, the user provides a good estimate of the initial starting point for the VCO core (VCO\_SEL), band (VCO\_CAPCTRL\_STRT), and amplitude (VCO DACISET STRT). To do the partial assist for the VCO calibration, follow this procedure:

- 1. Pick a VCO core that includes the desired VCO frequency. If at the boundary of two cores, choose based on phase noise or performance.
- 2. Use Equation 5 to find the approximate band:

$$VCO\_CAPCTRL\_STRT = Round[C_{Min} - (f_{VCO} - f_{Min}) \times (C_{Min} - C_{Max}) / (f_{Max} - f_{Min})]$$
(5)

3. Use Equation 6 to find the approximate amplitude setting.

$$VCO\_DACISET\_STRT = Round[A_{Min} - (f_{VCO} - f_{Min}) \times (A_{Min} - A_{Max}) / (f_{Max} - f_{Min})]$$
(6)

# Table 136. VCO Core Parametric

VCO CORE	f <sub>Min</sub> (MHz)	f <sub>Max</sub> (MHz)	C <sub>Min</sub>	C <sub>Max</sub>	A <sub>Min</sub>	A <sub>Max</sub>
VCO1	3200	3650	131	19	138	137
VCO2	3650	4200	143	25	162	142
VCO3	4200	4650	135	34	126	114
VCO4	4650	5200	136	25	195	172
VCO5	5200	5750	133	20	190	163
VCO6	5750	6400	151	27	256	204

#### 8.1.4.2 Close Frequency Assist

Upon initialization of the device, the user enables the QUICK\_RECAL\_EN bit. The next VCO calibration will use the current VCO core, band, and amplitude settings as the initial starting point. This approach is useful if the frequency change is small, say 50 MHz or so.

#### 8.1.4.3 Full Assist

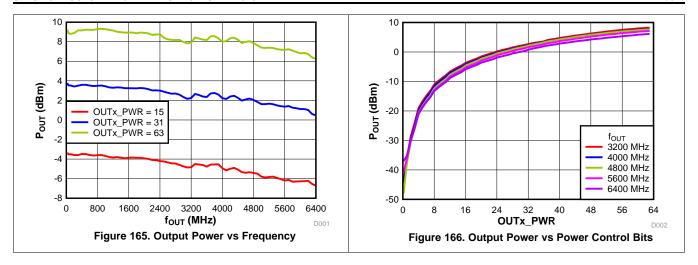
The user forces the VCO core (VCO\_SEL), band (VCO\_CAPCTRL), and amplitude (VCO\_DACISET) and manually sets the value. No VCO calibration will be performed. To force the set values, set VCO\_SEL\_FORCE, VCO\_CAPCTRL\_FORCE, and VCO\_DACISET\_FORCE equal 1. First do a VCO calibration and then read back the values to obtain the set values.

#### 8.1.5 Output Buffer Control

#### 8.1.5.1 Output Power

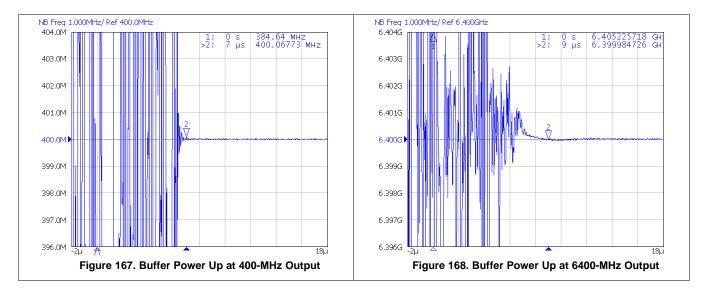
The OUTA\_PWR and OUTB\_PWR registers can be used to control the output power of the output buffers. The change in output power becomes not obvious when these registers values are over 35.





#### 8.1.5.2 Power-Up Response

Use the OUTx\_PD bits to power up or power down the output buffers. The RF output will vanish immediately when the buffer is powered down. However, it takes some tiny amount of time for it to power up. The response time is shorter if the output frequency is lower.



#### 8.1.5.3 Unused Output Pin

Each output buffer has two differential pair pins. The buffer can be used as a single differential output or two single-ended outputs. If only one single-ended output is necessary, the unused pin cannot be left open. The pin should be terminated properly as shown in Figure 169.

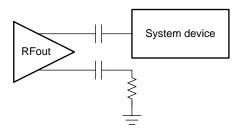


Figure 169. Unused Output Buffer Differential Pin

Product Folder Links: LMX2572

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#### 8.1.6 Application for SYNC

The requirements for SYNC depend on certain setup conditions. In cases where the SYNC is not timing critical, the setup can be done through software by toggling the VCO\_PHASE\_SYNC\_EN bit from 0 to 1. When the SYNC is timing critical, then setup must be done through the SYNC pin and the setup and hold times for the OSCin pin are critical.

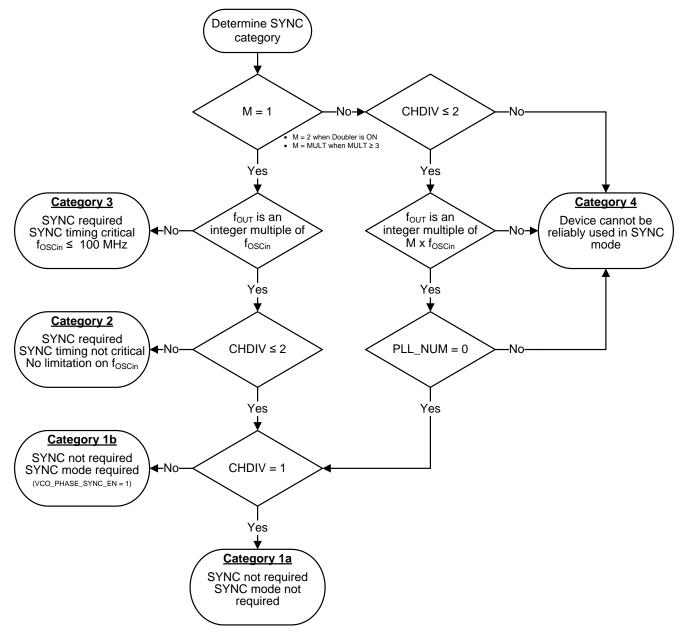


Figure 170. SYNC Category



The procedure for using SYNC in different SYNC categories is shown in Table 137.

Table 137. Procedure for Using SYNC

CATEGORY	CHARACTERISTIC	SETUP PROCEDURE
1a	<ul><li>SYNC not required.</li><li>SYNC mode not required.</li></ul>	<ol> <li>Setup as usual.</li> <li>Program all the registers as usual. The phase relationship between OSCin and f<sub>OUT</sub> will always be deterministic.</li> </ol>
1b	<ul><li>SYNC not required.</li><li>SYNC mode required.</li></ul>	<ol> <li>Set N = N' / 2, where N' is the normal N divider value.</li> <li>Program all the registers with R0 VCO_PHASE_SYNC_EN = 1.</li> </ol>
2	<ul> <li>SYNC required.</li> <li>SYNC timing not critical.</li> <li>No limitation on f<sub>OSCin</sub>.</li> </ul>	<ol> <li>Setup as usual.</li> <li>Program all the registers as usual. The device is now locked.</li> <li>Program N = N' / 2, where N' is the normal (original) N divider value.</li> <li>Program R0 with VCO_PHASE_SYNC_EN = 1.</li> <li>Program N = N'.</li> <li>Program R0 with VCO_PHASE_SYNC_EN = 0.</li> <li>Alternatively, step 3 to 6 can be replaced by applying a SYNC signal (0 → 1 transition) to the SYNC pin and the timing on this in not critical.</li> </ol>
3	<ul> <li>SYNC required.</li> <li>SYNC timing critical.</li> <li>f<sub>OSCin</sub> ≤ 100 MHz</li> </ul>	<ol> <li>Ensure that the maximum f<sub>OSCin</sub> for SYNC is not violated and there are hardware accommodations to use the SYNC pin.</li> <li>If neither OUTA_MUX nor OUTB_MUX is equal to 0 (Channel divider output), program N divider as usual.</li> <li>If one of the OUTA_MUX or OUTB_MUX is equal to 1, set N = N' / 2, where N' is the normal N divider (integer + fraction) value.</li> <li>Program all the registers with R0 VCO_PHASE_SYNC_EN = 1.</li> <li>Apply a SYNC signal (0 → 1 transition) to the SYNC pin. The timing of the SYNC signal as shown in Timing Requirements must be obey.</li> </ol>

Set these bits to drive the SYNC pin with a LVDS signal:

- Set INPIN FMT to 1 or 3 to enable LVDS input
- Set INPIN\_LVL to one of the options
- Set INPIN\_HYST, if necessary

The LVDS driver that is driving the SYNC pin should be configured as shown in Figure 171:

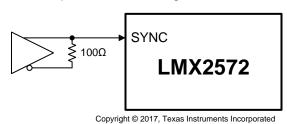


Figure 171. Driving SYNC Pin With Differential Signal



#### 8.1.7 Application for Ramp

#### 8.1.7.1 Manual Ramping Mode

Manual ramping is enabled when the user sets RAMP\_EN = 1 and RAMP\_MANUAL = 1. In this mode, the ramp is clocked by the rising edges applied to the RampClk pin. The size of the frequency change is defined by RAMP0\_INC and RAMP1\_INC. If a LOW is seen at the RampDir pin on the rising edge of RampClk, the output frequency will be incremented by RAMP1\_INC if a HIGH is captured. If a rising edge is seen on the RampClk pin while the VCO is calibrating, then this rising edge is ignored. The frequency for the RampClk must be limited to a frequency of 250 kHz or less, and the rising edge of the RampDir signal must be targeted to the falling edge of the RampClk pin. The necessary register fields for use in manual ramping mode are shown in Table 138.

**Table 138. Manual Ramping Mode Programming** 

REGISTER FIELD	VALUE	DESCRIPTION
RAMP_EN	1 = Enable ramp	Set this bit to 1 to enable frequency ramping.
RAMP_MANUAL	1 = Manual ramping mode	To select manual ramping mode, set this bit to 1.
RAMP_LIMIT_HIGH	Greater than the highest VCO ramp frequency	This sets the upper ramp limit that the ramp cannot go above. Suppose $f_{High}$ is this frequency and $f_{Start}$ is the starting VCO ramp frequency, then, for $f_{High} > f_{Start}$ , RAMP_LIMIT_HIGH = $2^{24} \times (f_{High} - f_{Start}) / f_{PD}$
RAMP_LIMIT_LOW	Smaller than the lowest VCO ramp frequency	This sets the lower ramp limit that the ramp cannot go below. Suppose $f_{Low}$ is this frequency and $f_{Start}$ is the starting VCO ramp frequency, then, for $f_{Start} > f_{Low}$ , RAMP_LIMIT_LOW = $2^{33} - 2^{24} \times (f_{Start} - f_{Low}) / f_{PD}$
RAMP0_INC RAMP1_INC	Equal to the ramp size	Suppose the ramp size is $\Delta f$ , then RAMPx_INC = $(\Delta f / f_{PD}) \times 2^{24}$ or = $2^{30} - (\Delta f / f_{PD}) \times 2^{24}$ if $\Delta f$ is a negative number.
RAMP_THRESH	Suggest less than 50 MHz	If the amount of frequency ramp exceeds this threshold, a VCO calibration will be initiated. For example, if the ramp size is 50 MHz while this threshold is 30 MHz, then VCO calibration will be executed every time it ramps. Suppose the threshold frequency is $f_{TH}$ , then RAMP_THRESH = $(f_{TH} / f_{PD}) \times 2^{24}$
RAMP_TRIGA RAMP_TRIGB	1 = RampClk rising edge trigger	In manual ramping mode, the ramp is triggered by the rising edges applied to the RampClk pin.  Either RAMP_TRIGA or RAMP_TRIGB can be selected as the trigger source for the next ramp.
RAMP0_NEXT_TRIG RAMP1_NEXT_TRIG	Equal to the selected RAMP_TRIGx	These fields define what triggers the next ramp. They must be set to the same trigger source selected above.

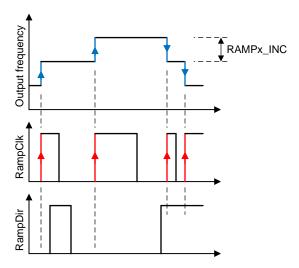


Figure 172. Manual Ramp Waveform



#### 8.1.7.2 Automatic Ramping Mode

Automatic ramping mode is enabled when RAMP\_EN = 1 with RAMP\_MANUAL = 0. In this mode, there are two ramps profiles that one can use to set the length and frequency change. In addition to this, there are ramp limits that can be used to create more complicated waveforms. The output frequency will ramp once on each phase detector cycle.

Automatic ramping can really be divided into two classes depending on whether the VCO must calibrate in the middle of the ramping or not. If the VCO can go the entire range without calibrating, this is calibration-free ramping. Note that this range is less at hot temperatures and less for lower frequency VCOs. This range is not ensured, so margin must be built into the design.

For ramping that are not calibration free, the ramp waveform is more like a staircase ramp.

**Table 139. Automatic Ramping Mode Programming** 

Table 133. Automatic Ramping mode i rogramming						
REGISTER FIELD	VALUE	DESCRIPTION				
RAMP_EN	1 = Enable ramp	Set this bit to 1 to enable frequency ramping.				
RAMP_MANUAL	0 = Automatic ramping mode	To select automatic ramping mode, set this bit to 0.				
RAMP_LIMIT_HIGH	Greater than the highest VCO ramp frequency	This sets the upper ramp limit that the ramp cannot go above. Suppose $f_{High}$ is this frequency and $f_{Start}$ is the starting VCO ramp frequency, then, for $f_{High} > f_{Start}$ , RAMP_LIMIT_HIGH = $2^{24} \times (f_{High} - f_{Start}) / f_{PD}$				
RAMP_LIMIT_LOW	Smaller than the lowest VCO ramp frequency	This sets the lower ramp limit that the ramp cannot go below. Suppose $f_{Low}$ is this frequency and $f_{Start}$ is the lowest VCO ramp frequency, then, for $f_{Start} > f_{Low}$ , RAMP_LIMIT_LOW = $2^{33} - 2^{24} \times (f_{Start} - f_{Low}) / f_{PD}$				
RAMP0_INC RAMP1_INC	Equal to the ramp size	Suppose the ramp size is $\Delta f$ , then RAMPx_INC = $(\Delta f / f_{PD}) \times 2^{24}$ or = $2^{30} - (\Delta f / f_{PD}) \times 2^{24}$ if $\Delta f$ is a negative number.				
RAMP_THRESH	Suggest less than 50 MHz	If the amount of frequency ramp exceed this threshold, a VCO calibration will be initiated. For example, if the ramp size is 15 MHz while this threshold is 20 MHz, then VCO calibration will be executed every two ramps. Suppose the threshold frequency is $f_{TH}$ , then RAMP_THRESH = $(f_{TH} / f_{PD}) \times 2^{24}$				
RAMP0_LEN RAMP1_LEN	0 to 2 <sup>16</sup>	Set the number of ramp required in each ramp profile. Maximum value is $2^{16}$ . If this number is exceeded, enable the RAMPx_DLY bit or reduce the phase detector frequency. RAMPx_LEN = Ramp duration of a ramp profile $\times$ f <sub>PD</sub>				
RAMP0_DLY RAMP1_DLY	0 or 1	If this bit is set to 1, the output frequency will ramp every two f <sub>PD</sub> cycles.				
RAMP0_NEXT RAMP1_NEXT	Equal to the next ramp	Set the next ramping profile when the present profile is finished.				
RAMP0_NEXT_TRIG RAMP1_NEXT_TRIG	0 = RAMP_LENx time out counter	Set these bits to 0 in order to start the next ramp immediately after the previous ramp.				
RAMP0_RST RAMP1_RST	0 or 1	If the stop frequency of the present ramp profile is different from the start frequency of the next ramp profile, set this bit to 1.				
RAMP_SCALE_COU NT RAMP_DLY_CNT	Suggest a minimum pause time of 50 µs	These two register fields set the minimum pause time when RAMP_THRESH is hit. This pause time must be sufficient to allow the VCO to complete a calibration, otherwise it will be overwritten by the actual VCO calibration time. Minimum pause time = RAMP_DLY_CNT $\times$ 2 <sup>RAMP_SCALE_COUNT</sup> $\times$ 2 <sup>CAL_CLK_DIV</sup> / f <sub>OSCin</sub>				



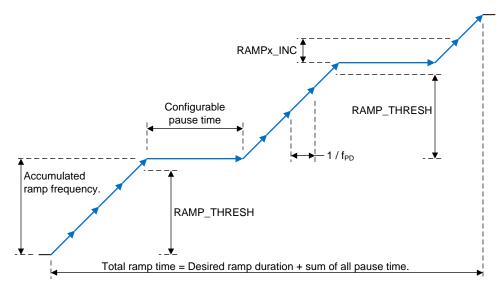


Figure 173. Auto Ramp Waveform

#### 8.1.8 Application for SYSREF

SYSREF consists of multiple dividers and a delay circuitry. The dividers include two fixed value dividers, a Pre-SR divider (SYSREF DIV PRE), and a Post-SR divider (SYSREF DIV).



Figure 174. SYSREF

SYSREF output frequency, f<sub>SYSREF</sub>, is calculated by Equation 7:

$$f_{SYSREF} = f_{VCO} / (4 \times SYSREF_DIV_PRE \times SYSREF_DIV)$$
(7)

The delay circuitry is consist of 4 counters (JESD\_DAC1\_CTRL, JESD\_DAC2\_CTRL, JESD\_DAC3\_CTRL, and JESD\_DAC4\_CTRL). Altogether, there are 200 useful programmable steps and each step is approximately a 5 ps (Pre-SR divider = 2) or 10 ps (Pre-SR divider = 4) delay. The values of the counters must be set in accordance to Table 140.

Table 140. SYSREF Delay Step

DELAY STEP NUMBER	JESD_DAC1_CTRL	JESD_DAC2_CTRL	JESD_DAC3_CTRL	JESD_DAC4_CTRL
0	36	27	0	0
36	0	63	0	0
37	0	62	1	0
99	0	0	63	0
100	0	0	62	1
162	0	0	0	63
163	1	0	0	62
200	38	0	0	25
> 200	Invalid	Invalid	Invalid	Invalid



Table 141 summarizes the usage boundaries of all functional blocks in SYSREF.

#### **Table 141. SYSREF Boundaries**

PARAMETER	VALUE	NOTES
Pre-SR divider	1 (Bypassed), 2, 4	
Post-SR divider	4, 6, 8, 10,, 4096, 4098	Input frequency range: 400 to 2300 MHz
Number of SYSREF pulse in Pulsed mode	1, 2, 3,, 14, 15	
Number of delay step	0 (No additional delay), 1, 2, 3,, 199, 200	

Since SYSREF operation requires enabling the VCO\_PHASE\_SYNC\_EN bit, during programming, set N = N' / 2, where N' is the normal N divider value.

#### 8.1.8.1 Driving SysRefReq Pin With Differential Signal

By default, the SysRefReq pin is configured as CMOS type input.  $V_{IO}$  and  $V_{IH}$  as shown in the Electrical Specifications apply. In Repeater mode (SYSREF\_REPEAT = 1), there is an option to program this pin to support LVDS input signal.

- Set INPIN\_FMT to 2 or 3 to enable LVDS input
- Set INPIN\_LVL to one of the options
- Set INPIN\_HYST if necessary

The LVDS driver that is driving the SysRefReq pin should be configured like Figure 175:

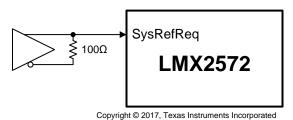


Figure 175. Driving SysRefReq Pin With Differential Signal

#### 8.1.8.2 SYSREF Output

The SYSREF output comes in differential format through RFoutB. The common mode output voltage of this driver is between 1.9 V to 2.3 V. If DC-coupling to the receiving device is not possible, there are two strategies for AC-coupling.

- 1. Send a series of pulses to establish a DC-bias level across the AC-coupling capacitor.
- Establish a bias voltage at the receiving device that is below the threshold voltage by using a resistive divider.

#### 8.1.9 Application for FSK

In fractional mode, the finest delta frequency difference between two programmable output frequencies is equal to Equation 8:

$$f_1 - f_2 = \Delta f_{min} = f_{PD} \times \{ [(PLL_N + 1) / PLL_DEN] - (PLL_N / PLL_DEN) \} = f_{PD} / PLL_DEN$$
 (8)

In other words, when the fractional numerator is incremented by 1 (one step), the output frequency will change by  $\Delta f_{min}$ . A two steps increment will therefore change the frequency by 2 ×  $\Delta f_{min}$ .

In FSK operation, the instantaneous carrier frequency is kept changing among some pre-defined frequencies. In general, the instantaneous carrier frequency is defined as a certain frequency deviation from the nominal carrier frequency. The frequency deviation could be positive and negative.



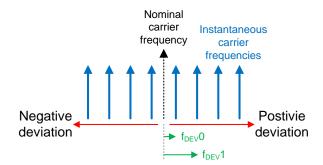


Figure 176. General FSK Definition

Equation 9 and Equation 10 define the number of steps required for the desired frequency deviation with respect to the nominal carrier frequency output. Assume  $\Delta f_{DEV}$  is the frequency deviation,

For positive deviation, FSK step = Round[
$$(\Delta f_{DEV} \times PLL_DEN \times CHDIV) / (f_{PD} \times 2^{FSK_DEV_SCALE})$$
] (9)

For negative deviation, FSK step =  $2^{16}$  – the positive deviation, FSK step answer (10)

In FSK SPI mode, registers R116 – R123 are used to store the desired FSK steps as defined in Equation 9 and Equation 10. The order of the registers, 0 to 7, depends on the application system. A typical 4FSK definition is shown in Figure 177. In this case, the FSK\_DEV0 and FSK\_DEV1 are calculated using Equation 9, while the FSK\_DEV2 and FSK\_DEV3 are calculated using Equation 10.

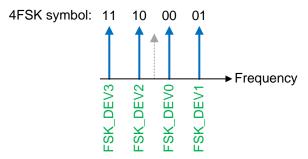


Figure 177. Typical 4FSK Definition

FSK SPI mode assumes the user knows which symbol to send. The user can directly write to FSK\_SPI\_DEV\_SEL to select the desired frequency deviation. For example, to enable the device to support 4FSK modulation in FSK SPI mode, set:

- FSK\_MODE\_SEL = 2 (FSK SPI)
- FSK SPI LEVEL = 2 (4FSK)
- FSK\_EN = 1

Table 142. FSK SPI Mode Example

DESIRED SYMBOL	WRITE REGISTER FSK_SPI_DEV_SEL	REGISTER SELECTED
10	2	FSK_DEV2
11	3	FSK_DEV3
10	2	FSK_DEV2
11	3	FSK_DEV3
01	1	FSK_DEV1
00	0	FSK_DEV0



FSK SPI mode supports up to eight levels of FSK. To support an arbitrary-level FSK, use FSK SPI FAST mode. Constructing pulse-shaping FSK modulation by over-sampling the FSK modulation waveform is one of the used cases of this mode.

Analog-FM modulation can also be produced in this mode. For example, with a 1-kHz sine wave modulation signal with peak frequency deviation of ±2 kHz, the signal can be oversampled, say 10 times. Each sample point corresponding to a scaled frequency deviation.

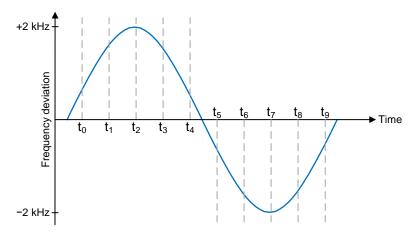


Figure 178. Oversampling Modulation Signal

In FSK SPI FAST mode, write the desired FSK steps directly to FSK\_SPI\_FAST\_DEV. To enable this mode, set:

- FSK\_MODE\_SEL = 3 (FSK SPI FAST)
- FSK EN = 1

Table 143. FSK SPI FAST Mode Example

TIME	FREQUENCY DEVIATION (Hz)	CORRESPONDING FSK STEPS <sup>(1)</sup>	WRITE TO FSK_SPI_FAST_DEV
t <sub>0</sub>	618.034	396	396
t <sub>1</sub>	1618.034	1036	1036
t <sub>2</sub>	2000	1280	1280
t <sub>6</sub>	-1618.034	64500	64500
t <sub>7</sub>	-2000	64256	64256

<sup>(1)</sup>  $f_{VCO} = 3840 \text{ MHz}, f_{OUT} = 480 \text{ MHz}, f_{PD} = 100 \text{ MHz}, CHDIV = 8, PLL_DEN = 8000000, FSK_DEV_SCALE = 0.$ 

Block Programming is possible with FSK SPI FAST mode programming as long as ADD\_HOLD = 1, which will freeze the register address after the first register write. The same programming sequent as shown in Figure 37 applies.

#### 8.1.10 Unused Pins

TI recommends to pull these pins low if they are not used:

- Pin 5, SYNC
- Pin 28, SysRefReq
- Pin 30, RampClk
- Pin 32, RampDir



#### 8.1.11 External Loop Filter

The LMX2572 requires an external loop filter that is application-specific and can be configured by PLLatinum Sim. For the LMX2572, it matters what impedance is seen from the Vtune pin looking outwards. This impedance is dominated by the component C3 for a third order filter or C1 for a second order filter. If there is at least 1.5 nF for the capacitance that is shunt with this pin, the VCO phase noise will be close to the best it can be. If there is less, the VCO phase noise in the 100-kHz to 1-MHz region will degrade. This capacitor should be placed close to the Vtune pin.

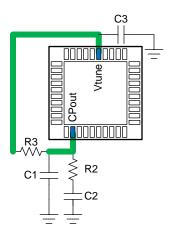


Figure 179. External Loop Filter

### 8.1.12 Power-Up, Wake-Up Time

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When the device comes out of the powered-down state, either by resuming the POWERDOWN bit to zero or by pulling back CE pin HIGH (if it was powered down by CE pin), it takes time for the device to acquire lock again. This wake-up time depends on LDO\_DLY setting, loop bandwidth, and the state machine clock frequency (=  $f_{OSCin} / 2^{CAL\_CLK\_DIV}$ ). If the loop bandwidth is greater than 20 kHz, the wake-up time could be adjusted to less than 1.5 ms with the LDO\_DLY setting listed in Table 144.

Table 144. LDO\_DLY Setting

STATE MACHINE CLOCK FREQUENCY	LDO_DLY
130 MHz ≤ f ≤ 200MHz	8
80 MHz ≤ f < 130 MHz	5
50 MHz ≤ f < 80 MHz	3
30 MHz ≤ f < 50 MHz	2
f < 30 MHz	1



## 8.2 Typical Application

This application example demonstrates how to set up the LMX2572 in FSK SPI FAST mode to synthesize 4-level GFSK modulation.

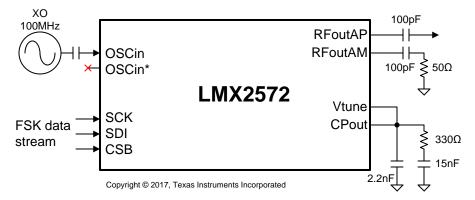


Figure 180. Application Example Schematic

## 8.2.1 Design Requirements

Table 145 lists the design parameters for this example.

**Table 145. Design Parameters** 

PARAMETER	EXAMPLE VALUE
OSCin frequency	100 MHz
RFout frequency	490 MHz
4FSK modulation baud rate	125 kSps
BT of Gaussian filter	0.4
FSK frequency deviation	±17 kHz and ±51 kHz
Fractional denominator	8000000

### 8.2.2 Detailed Design Procedure

First, determine all the elementary blocks of a synthesizer.

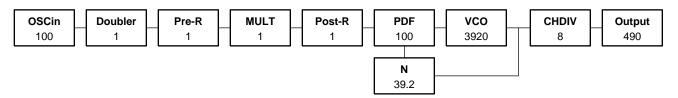


Figure 181. Application Example Frequency Plan



Then, program these registers to make LMX2572 locks to the target output frequency:

- OSC 2X = 0
- PLL R PRE = 1
- MULT = 1
- PLL\_R = 1
- PLL\_N[18:16] = 0; PLL\_N[15:0] = 39
- PLL\_NUM[31:16] = 24; PLL\_NUM[15:0] = 27136
- PLL\_DEN[31:16] = 122; PLL\_DEN[15:0] = 4680
- CHDIV = 8

Then program these registers to enable FSK SPI FAST mode:

- FSK\_MODE\_SEL = 3
- FSK\_DEV\_SCALE = 1
- FSK EN = 1

A Mathlab script is then developed to generate the necessary codes that will be used to continuously bit-stream the LMX2572. These codes are uploaded to the data generator DG2020, which will generate the SPI data to *modulate* the LMX2572.

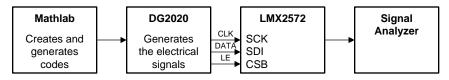
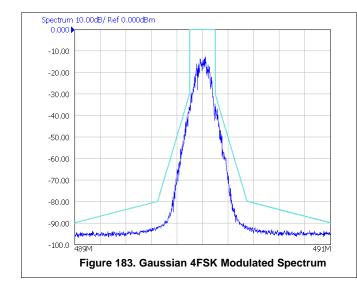


Figure 182. Application Example Test Setup

## 8.2.3 Application Curves



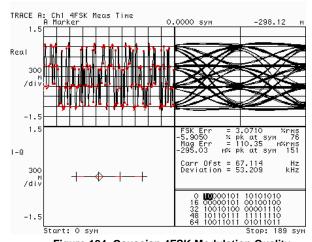


Figure 184. Gaussian 4FSK Modulation Quality

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## 8.3 Do's and Don'ts

- RFout output buffers do not need an external pullup. An AC-couple to the load is good enough.
- The last shunt capacitor of the loop filter should be placed close to the Vtune pin.

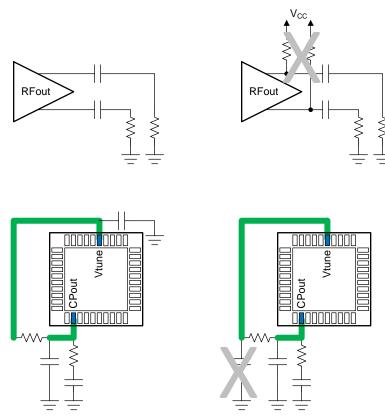


Figure 185. Do's and Don'ts

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## 9 Power Supply Recommendations

TI recommends placing a 100-nF capacitor close to each of the power supply pins. If fractional spurs are a large concern, use a ferrite bead to each of these power supply pins to reduce spurs to a small degree. This device has integrated LDOs, which improves the resistance to power supply noise. Figure 186 is a typical application example.

This device can be powered by an external DC/DC buck converter, such as the TPS62150. Note that although Rtps1 and Rtps2 are 1.5  $\Omega$  in the schematic, they could be potentially replaced with a larger resistor value or inductor value for better power supply filtering. Alternatively, the use of a larger capacitance value for C2 and C4 could also result in better power supply filtering.

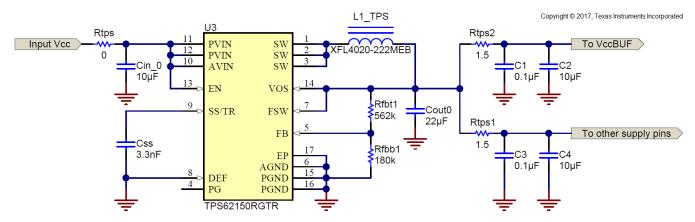
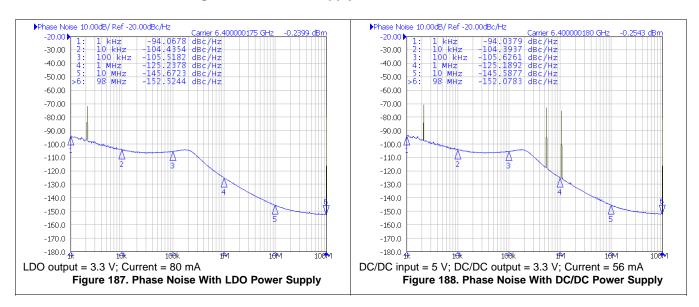


Figure 186. Power Supply With a DC/DC Converter



The power consumption of LMX2572 depends on its configuration. The data as shown in the Electrical Characteristics table represent the current consumption at some specific conditions. It is possible to get a smaller or higher current consumption than what is specified in the data sheet. To get a rough estimation on current consumption at a particular configuration, use TICS Pro.



## 10 Layout

### 10.1 Layout Guidelines

In general, the layout guidelines are similar to most other PLL devices. Here are some specific guidelines:

- GND pins may be routed on the package back to the DAP.
- The OSCin pins are internally biased and must be AC-coupled.
- The RampClk, RampDir, and SysRefReq can be grounded to the DAP if not used.
- Get a loop filter capacitor as close to the Vtune pin as possible to this. This may mean separating it from the rest of the loop filter.
- If a single-ended output is necessary, the other side must have the same loading. However, the routing for the used side can be optimized by routing the complementary side through a via to the other side of the board. On this side, make the load look equivalent to the side that is used.
- Ensure the DAP on the device is well-grounded with many vias, preferably copper filled.
- Have a thermal pad that is as large as the exposed pad. Add vias to the thermal pad to maximize thermal
  performance.
- Use a low loss dielectric material, such as Rogers 4003, for optimal output power.

## 10.2 Layout Example

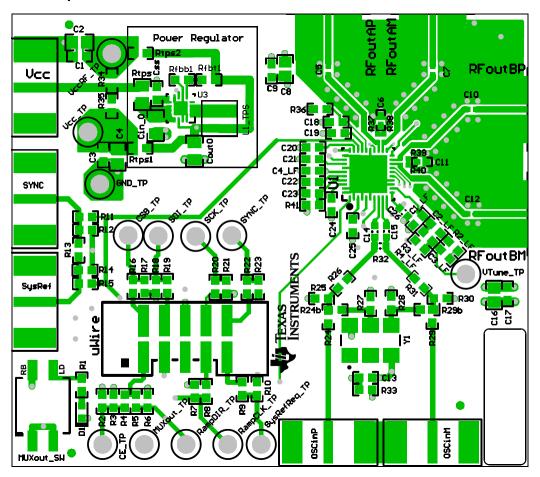


Figure 189. Layout Example



# 11 Device and Documentation Support

## 11.1 Device Support

### 11.1.1 Development Support

Texas Instruments has several software tools to aid in the development at www.ti.com. Among these tools are:

- PLLatinum Sim program for designing loop filters, simulating phase noise and spurs.
- TICS Pro software to understand how to program the device and for programming the EVM board.

### 11.2 Documentation Support

#### 11.2.1 Related Documentation

For related documentation see the following:

- TPS62150 3–17V 1A Step-down converter with dcs-control (SLVSAL5)
- AN-1879 Fractional N frequency synthesis (SNAA062)
- Frequency shift keying with LMX2571 (SNAA309)
- PLL performance, simulation, and design handbook (SNAA106)
- LMX2572EVM User's guide (SNAU217)

# 11.3 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on *Alert me* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

## 11.4 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's Terms of Use.

TI E2E™ Online Community T's Engineer-to-Engineer (E2E) Community. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.5 Trademarks

E2E is a trademark of Texas Instruments.

All other trademarks are the property of their respective owners.

### 11.6 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

## 11.7 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

# 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.



# PACKAGE OPTION ADDENDUM

10-Dec-2020

#### PACKAGING INFORMATION

www.ti.com

Orderable Device	Status	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
LMX2572RHAR	ACTIVE	VQFN	RHA	40	2500	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	LMX2572	Samples
LMX2572RHAT	ACTIVE	VQFN	RHA	40	250	RoHS & Green	NIPDAU	Level-3-260C-168 HR	-40 to 85	LMX2572	Samples

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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10-Dec-2020

# **PACKAGE MATERIALS INFORMATION**

www.ti.com 25-Sep-2024

## TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
LMX2572RHAR	VQFN	RHA	40	2500	330.0	16.4	6.3	6.3	1.5	12.0	16.0	Q1
LMX2572RHAT	VQFN	RHA	40	250	178.0	16.4	6.3	6.3	1.5	12.0	16.0	Q1

www.ti.com 25-Sep-2024



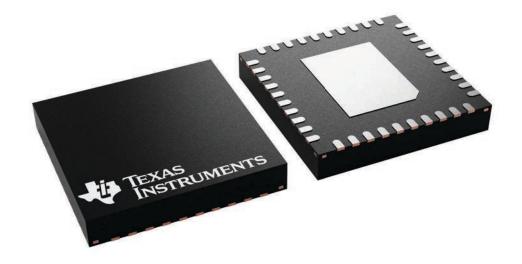
## \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
LMX2572RHAR	VQFN	RHA	40	2500	356.0	356.0	36.0
LMX2572RHAT	VQFN	RHA	40	250	208.0	191.0	35.0

6 x 6, 0.5 mm pitch

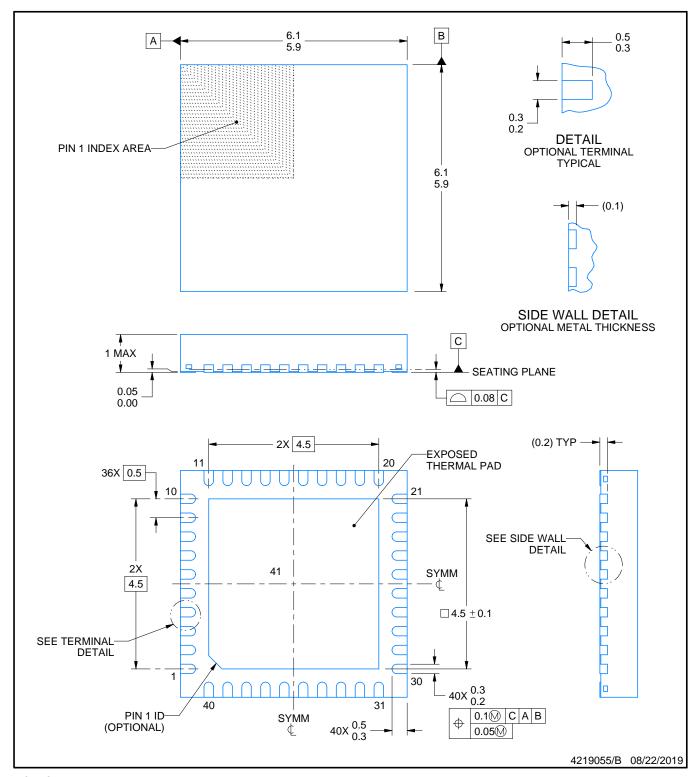
PLASTIC QUAD FLATPACK - NO LEAD

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.





PLASTIC QUAD FLATPACK - NO LEAD

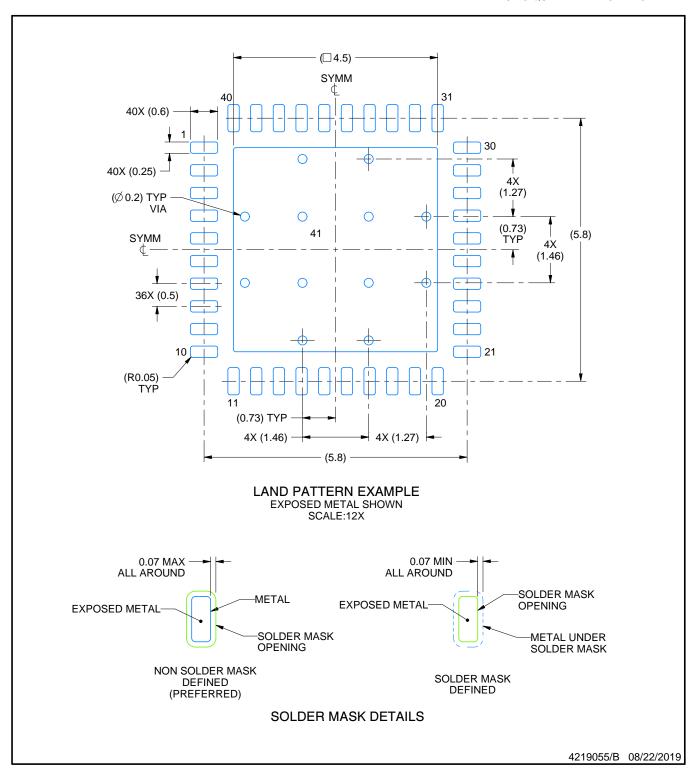


## NOTES:

- 1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. The package thermal pad must be soldered to the printed circuit board for thermal and mechanical performance.



PLASTIC QUAD FLATPACK - NO LEAD

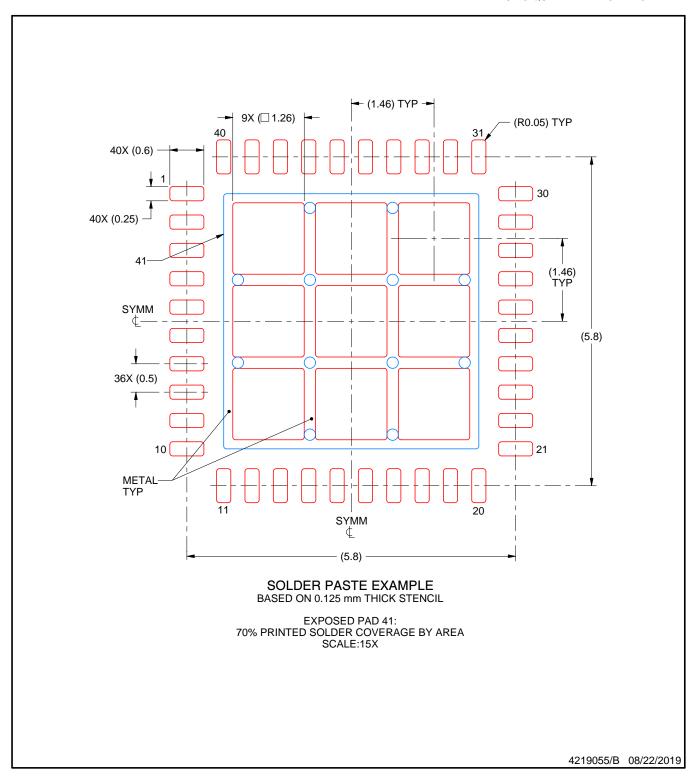


NOTES: (continued)

- 4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 (www.ti.com/lit/slua271).
- 5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.



PLASTIC QUAD FLATPACK - NO LEAD



NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.



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